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R8C/22 Group, R8C/23 Group RENESAS MCU

REJ03B0097-0200 Rev.2.00 Aug 20, 2008

1. Overview

This MCU is built using the high-performance silicon gate CMOS process using the R8C CPU core and is packaged in a 48-pin plastic molded LQFP. This MCU operates using sophisticated instructions featuring a high level of instruction efficiency. With 1 Mbyte of address space, it is capable of executing instructions at high speed. This MCU is equipped with one CAN module and suited to in-vehicle or FA networking.

Furthermore, the data flash (1 KB x 2 blocks) is embedded in the R8C/23 Group.

The difference between R8C/22 and R8C/23 Groups is only the existence of the data flash. Their peripheral functions are the same.

1.1 Applications

Automotive, etc.



1.2 Performance Overview

Table 1.1 outlines the Functions and Specifications for R8C/22 Group and Table 1.2 outlines the Functions and Specifications for R8C/23 Group.

Table 1.1 Functions and Specifications for R8C/22 Group

	Item	Specification
CPU	Number of fundamental instructions	· · · · · · · · · · · · · · · · · · ·
01 0	Minimum instruction execution time	50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V)
	William and addition excedition and	100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)
	Operating mode	Single-chip
	Address space	1 Mbyte
	Memory capacity	Refer to Table 1.3 Product Information for R8C/22 Group
Peripheral	Ports	I/O ports: 41 pins, Input port: 3 pins
Function	Timers	Timer RA: 8 bits x 1 channel,
		Timer RB: 8 bits x 1 channel
		(Each timer equipped with 8-bit prescaler)
		Timer RD: 16 bits x 2 channel
		(Circuits of input capture and output compare)
		Timer RE: With compare match function
	Serial interface	1 channel (UART0)
		Clock synchronous I/O, UART
		1 channel (UART1)
		UART '
	Clock synchronous serial interface	1 channel
	,	I ² C bus interface ⁽²⁾ , Clock synchronous serial I/O with chip
		select
	LIN module	Hardware LIN: 1 channel
		(timer RA, UART0)
	CAN module	1 channel with 2.0B specification: 16 slots
	A/D converter	10-bit A/D converter: 1 circuit, 12 channels
	Watchdog timer	15 bits x 1 channel (with prescaler)
		Reset start selectable
	Interrupt	Internal: 14 sources, External: 6 sources, Software: 4 sources,
	·	Priority level: 7 levels
	Clock generation circuits	2 circuits
		XIN clock generation circuit (with on-chip feedback resistor)
		On-chip oscillator (high speed, low speed)
		High-speed on-chip oscillator has frequency adjustment
		function.
	Oscillation stop detection	Stop detection of XIN clock oscillation
	function	
	Voltage detection circuit	On-chip On-chip
	Power-on reset circuit include	On-chip
Electric	Supply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz)(D, J version)
Characteristics		VCC = 3.0 to 5.5 V (f(XIN) = 16 MHz)(K version)
		VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz)
	Current consumption	Typ. 12.5 mA (VCC = 5 V, f(XIN) = 20 MHz, High-speed on-
		chip oscillator stopping)
		Typ. 6.0 mA (VCC = 5 V, f(XIN) = 10 MHz, High-speed on-chip
		oscillator stopping)
Flash Memory	Programming and erasure voltage	VCC = 2.7 to 5.5 V
	Programming and erasure	100 times
	endurance	
Operating Ambi	ent Temperature	-40 to 85°C
		-40 to 125°C (option ⁽¹⁾)
Package		48-pin mold-plastic LQFP
Package		48-pin mold-plastic LQFP

- 1. When using options, be sure to inquire about the specification.
- 2. I²C bus is a registered trademark of Koninklijke Philips Electronics N.V.



Functions and Specifications for R8C/23 Group Table 1.2

	Itom	Charification		
CPU	Item	Specification Specification		
CPU	Number of fundamental instructions			
	Minimum instruction execution time	50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V) 100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)		
	Operating mode	Single-chip		
	Address space	1 Mbyte		
	Memory capacity	Refer to Table 1.4 Product Information for R8C/23 Group		
Peripheral	Ports	I/O ports: 41 pins, Input port: 3 pins		
Function	Timers	Timer RA: 8 bits x 1 channel,		
1 dilottori	Timers	Timer RB: 8 bits x 1 channel		
		(Each timer equipped with 8-bit prescaler)		
		Timer RD: 16 bits x 2 channel		
		(Circuits of input capture and output compare)		
		Timer RE: With compare match function		
	Serial interface	1 channel (UART0)		
		Clock synchronous I/O, UART		
		1 channel (UART1)		
		UART		
	Clock synchronous serial interface	1 channel		
		I ² C bus interface ⁽²⁾ , Clock synchronous serial I/O with chip		
		select		
	LIN module	Hardware LIN: 1 channel		
		(Timer RA, UART0)		
	CAN module	1 channel with 2.0B specification: 16 slots		
	A/D converter	10-bit A/D converter: 1 circuit, 12 channels		
	Watchdog timer	15 bits x 1 channel (with prescaler)		
	Laterwinte	Reset start selectable		
	Interrupts	Internal: 14 sources, External: 6 sources, Software: 4 sources, Priority level: 7 levels		
	Clock generation circuits	2 circuits		
	Clock generation circuits	XIN clock generation circuit (with on-chip feedback resistor)		
		On-chip oscillator (high speed, low speed)		
		High-speed on-chip oscillator has frequency adjustment		
		function.		
	Oscillation stop detection	Stop detection of XIN clock oscillation		
	function			
	Voltage detection circuit	On-chip		
	Power-on reset circuit include	On-chip		
Electric	Supply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz)(D, J version)		
Characteristics		VCC = 3.0 to 5.5 V (f(XIN) = 16 MHz)(K version)		
		VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz)		
	Current consumption	Typ. 12.5 mA (VCC = 5 V, f(XIN) = 20 MHz, High-speed on-		
		chip oscillator stopping)		
		Typ. 6.0 mA (VCC = 5 V, f(XIN) = 10 MHz, High-speed on-chip		
Flack Marra	Dro are main a and a second	oscillator stopping)		
Flash Memory	Programming and erasure voltage	VCC = 2.7 to 5.5 V		
	Programming and erasure	10,000 times (data flash)		
0	endurance	1,000 times (program ROM)		
Operating Ambie	ent Temperature	-40 to 85°C		
		-40 to 125°C (option ⁽¹⁾)		
Package		48-pin mold-plastic LQFP		

- 1. When using options, be sure to inquire about the specification.
- 2. I2C bus is a registered trademark of Koninklijke Philips Electronics N.V.



1.3 Block Diagram

Figure 1.1 shows a Block Diagram.

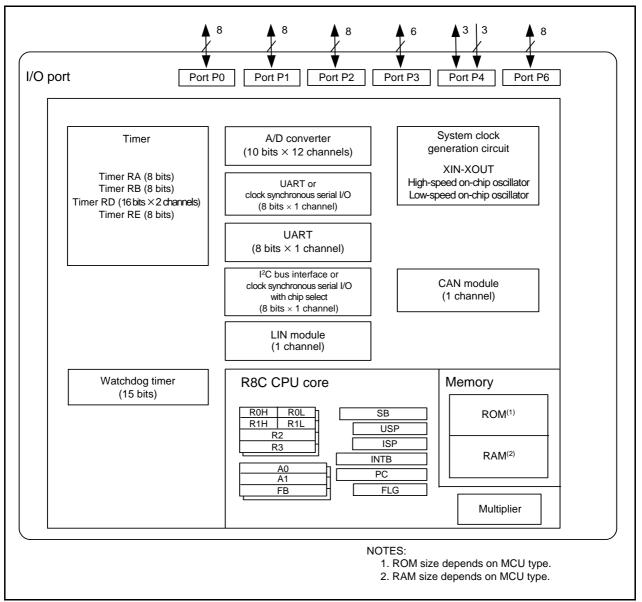


Figure 1.1 Block Diagram

1.4 Product Information

Table 1.3 lists Product Information for R8C/22 Group and Table 1.4 lists Product Information for R8C/23 Group.

Table 1.3 Product Information for R8C/22 Group

Current of Aug. 2008

Type No.	ROM Capacity	RAM Capacity	Package Type	Rer	narks
R5F21226DFP	32 Kbytes	2 Kbytes	PLQP0048KB-A	D version	Flash memory
R5F21227DFP	48 Kbytes	2.5 Kbytes	PLQP0048KB-A		version
R5F21228DFP	64 Kbytes	3 Kbytes	PLQP0048KB-A		
R5F21226JFP	32 Kbytes	2 Kbytes	PLQP0048KB-A	J version	
R5F21227JFP	48 Kbytes	2.5 Kbytes	PLQP0048KB-A		
R5F21228JFP	64 Kbytes	3 Kbytes	PLQP0048KB-A		
R5F2122AJFP	96 Kbytes	5 Kbytes	PLQP0048KB-A		
R5F2122CJFP	128 Kbytes ⁽¹⁾	6 Kbytes	PLQP0048KB-A		
R5F21226KFP	32 Kbytes	2 Kbytes	PLQP0048KB-A	K version	
R5F21227KFP	48 Kbytes	2.5 Kbytes	PLQP0048KB-A		
R5F21228KFP	64 Kbytes	3 Kbytes	PLQP0048KB-A		
R5F2122AKFP	96 Kbytes	5 Kbytes	PLQP0048KB-A		
R5F2122CKFP	128 Kbytes ⁽¹⁾	6 Kbytes	PLQP0048KB-A		

NOTE:

1. Do not use addresses 20000h to 23FFFh because these areas are used for the emulator debugger. Refer to **24. Notes on Emulator Debugger** of Hardware Manual.

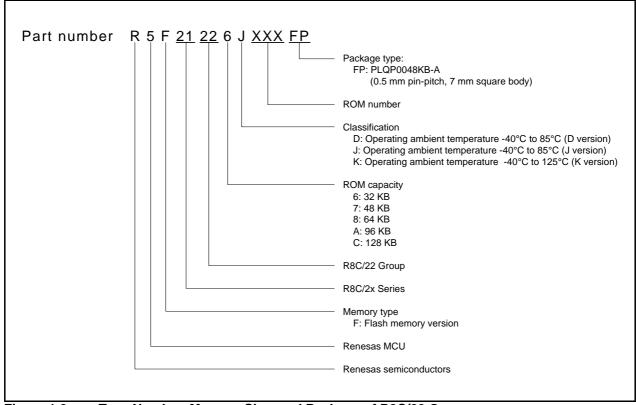


Figure 1.2 Type Number, Memory Size, and Package of R8C/22 Group

Table 1.4 **Product Information for R8C/23 Group**

Current of Aug. 2008

Type No.	ROM C	apacity	RAM Capacity	Package Type	Rema	arke
Type No.	Program ROM	Data Flash	TANI Capacity	Tackage Type	IXGIII	aiks
R5F21236DFP	32 Kbytes	1 Kbyte X 2	2 Kbytes	PLQP0048KB-A	D version	Flash
R5F21237DFP	48 Kbytes	1 Kbyte X 2	2.5 Kbytes	PLQP0048KB-A		memory
R5F21238DFP	64 Kbytes	1 Kbyte X 2	3 Kbytes	PLQP0048KB-A		version
R5F21236JFP	32 Kbytes	1 Kbyte X 2	2 Kbytes	PLQP0048KB-A	J version	
R5F21237JFP	48 Kbytes	1 Kbyte X 2	2.5 Kbytes	PLQP0048KB-A		
R5F21238JFP	64 Kbytes	1 Kbyte X 2	3 Kbytes	PLQP0048KB-A		
R5F2123AJFP	96 Kbytes	1 Kbyte X 2	5 Kbytes	PLQP0048KB-A		
R5F2123CJFP	128 Kbytes ⁽¹⁾	1 Kbyte X 2	6 Kbytes	PLQP0048KB-A		
R5F21236KFP	32 Kbytes	1 Kbyte X 2	2 Kbytes	PLQP0048KB-A	K version	
R5F21237KFP	48 Kbytes	1 Kbyte X 2	2.5 Kbytes	PLQP0048KB-A		
R5F21238KFP	64 Kbytes	1 Kbyte X 2	3 Kbytes	PLQP0048KB-A		
R5F2123AKFP	96 Kbytes	1 Kbyte X 2	5 Kbytes	PLQP0048KB-A		
R5F2123CKFP	128 Kbytes ⁽¹⁾	1 Kbyte X 2	6 Kbytes	PLQP0048KB-A		

NOTE:

1. Do not use addresses 20000h to 23FFFh because these areas are used for the emulator debugger. Refer to **24. Notes on Emulator Debugger** of Hardware Manual.

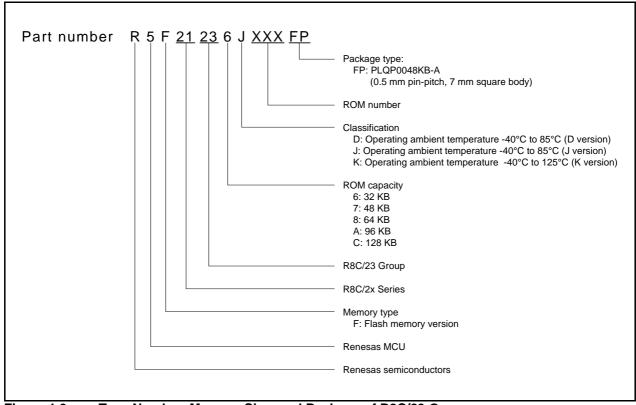


Figure 1.3 Type Number, Memory Size, and Package of R8C/23 Group

1.5 Pin Assignments

Figure 1.4 shows Pin Assignments (Top View).

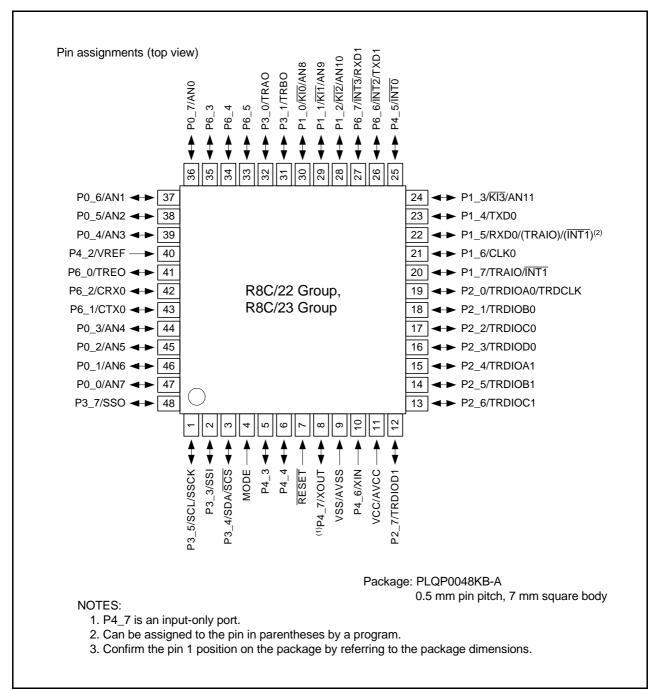


Figure 1.4 Pin Assignments (Top View)

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1.6 Pin Functions

Table 1.5 lists the Pin Functions and Table 1.6 lists the Pin Name Information by Pin Number.

Table 1.5 Pin Functions

Туре	Symbol	I/O Type	Description
Power Supply Input	VCC VSS	I	Apply 2.7 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog Power Supply Input	AVCC, AVSS	I	Applies the power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.
Reset Input	RESET	I	Input "L" on this pin resets the MCU.
MODE	MODE	I	Connect this pin to VCC via a resistor.
XIN Clock Input	XIN	I	These pins are provided for the XIN clock generation
XIN Clock Output	XOUT	0	circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins. To use an externally derived clock, input it to the XIN pin and leave the XOUT pin open.
INT Interrupt Input	INTO to INT3	I	INT interrupt input pins. INTO Timer RD input pins. INT1 Timer RA input pins.
Key Input Interrupt	KI0 to KI3	I	Key input interrupt input pins.
Timer RA	TRAIO	I/O	Timer RA I/O pin.
	TRAO	0	Timer RA output pin.
Timer RB	TRBO	0	Timer RB output pin.
Timer RD	TRDIOA0, TRDIOA1, TRDIOB0, TRDIOB1, TRDIOC0, TRDIOC1, TRDIOD0, TRDIOD1	I/O	Timer RD I/O ports.
	TRDCLK	I	External clock input pin.
Timer RE	TREO	0	Divided clock output pin.
Serial Interface	CLK0	I/O	Transfer clock I/O pin.
	RXD0, RXD1	I	Serial data input pins.
	TXD0, TXD1	0	Serial data output pins.
I ² C Bus Interface	SCL	I/O	Clock I/O pin.
	SDA	I/O	Data I/O pin.
Clock Synchronous	SSI	I/O	Data I/O pin.
Serial I/O with Chip	SCS	I/O	Chip-select signal I/O pin.
Select	SSCK	I/O	Clock I/O pin.
	SSO	I/O	Data I/O pin.
CAN Module	CRX0	I	CAN data input pin.
	CTX0	0	CAN data output pin.
Reference Voltage Input	VREF	I	Reference voltage input pin to A/D converter.
A/D Converter	AN0 to AN11	I	Analog input pins to A/D converter.
I/O Port	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0, P3_1, P3_3 to P3_5, P3_7, P4_3 to P4_5, P6_0 to P6_7	I/O	CMOS I/O ports. Each port contains an input/output select direction register, allowing each pin in that port to be directed for input or output individually. Any port set to input can select whether to use a pull-up resistor or not by a program.
Input Port	P4_2, P4_6, P4_7	I	Input only ports.

I: Input

O: Output

I/O: Input and output



Pin Name Information by Pin Number Table 1.6

				I/O Pin	Functions	for of Periphera	l Modules		
Pin Number	Control Pin	Port	Interrupt	Timer	Serial Interface	Clock Synchronous Serial I/O with Chip Select	I ² C Bus Interface	CAN Module	A/D Converter
1		P3_5				SSCK	SCL		
2		P3_3				SSI			
3		P3_4				SCS	SDA		
4	MODE								
5		P4_3							
6		P4_4							
7	RESET								
8	XOUT	P4_7							
9	VSS/AVSS								
10	XIN	P4_6							
11	VCC/AVCC								
12		P2_7		TRDIOD1					
13		P2_6		TRDIOC1					
14		P2_5		TRDIOB1					
15		P2_4		TRDIOA1					
16		P2_3		TRDIOD0					
17		P2_2		TRDIOC0					
18		P2_1		TRDIOB0					
19		P2_0		TRDIOA0/TRDCLK					
20		P1_7	ĪNT1	TRAIO					
21		P1_6			CLK0				
22		P1_5	(INT1) ⁽¹⁾	(TRAIO) ⁽¹⁾	RXD0				
23		P1_4	(11411)	(110.00)**	TXD0				
24		P1_3	KI3		TABO				AN11
25		P4_5		11.170					74411
			INT0	ĪNT0	TVD4				
26		P6_6	INT2		TXD1				
27		P6_7	INT3		RXD1				
28		P1_2	KI2						AN10
29		P1_1	KI1						AN9
30		P1_0	KI0						AN8
31		P3_1	TO	TRBO					
32		P3_0		TRAO					
33		P6_5							
34		P6_4							
35		P6_3							
36		P0_7							AN0
37		P0_6							AN1
38		P0_5							AN2
39		P0_4							AN3
40	VREF	P4_2							
41		P6_0		TREO					
42		P6_2						CRX0	
43		P6_1						CTX0	
44		P0_3							AN4
45		P0_2							AN5
46		P0_1							AN6
47		P0_0							AN7
48		P3_7				SSO			

NOTE:

1. Can be assigned to the pin in parentheses by a program.

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. Of these, R0, R1, R2, R3, A0, A1, and FB comprise a register bank. Two sets of register banks are provided.

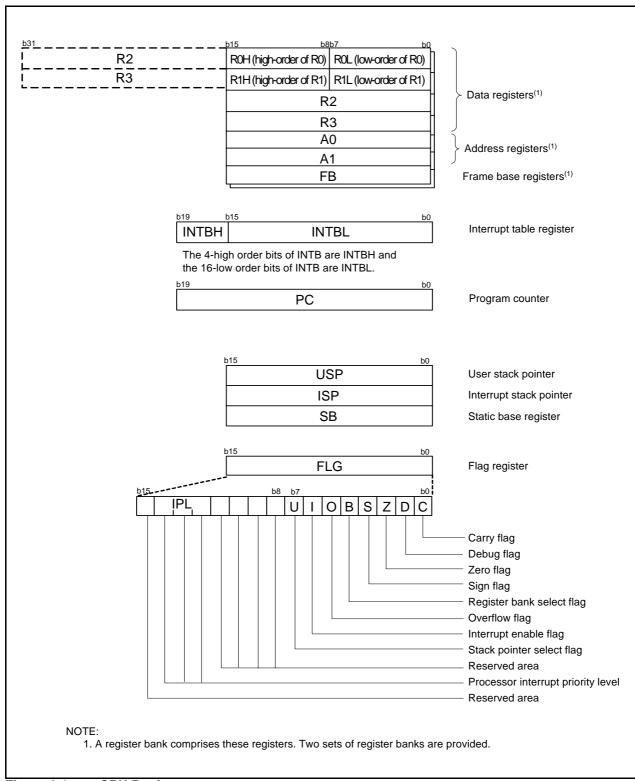


Figure 2.1 CPU Registers

2.1 Data Registers (R0, R1, R2 and R3)

R0 is a 16-bit register for transfer, arithmetic, and logic operations. The same applies to R1 to R3.

R0 can be split into high-order bit (R0H) and low-order bit (R0L) to be used separately as 8-bit data registers. The same applies to R1H and R1L as R0H and R0L. R2 can be combined with R0 to be used as a 32-bit data register (R2R0). The same applies R3R1 as R2R0.

2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. They also are used for transfer, arithmetic and logic operations. The same applies to A1 as A0.

A1 can be combined with A0 to be used a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB, a 20-bit register, indicates the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC, 20 bits wide, indicates the address of an instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointer (SP), USP and ISP, are 16 bits wide each.

The U flag of FLG is used to switch between USP and ISP.

2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

2.8 Flag Register (FLG)

FLG is a 11-bit register indicating the CPU status.

2.8.1 Carry Flag (C)

The C flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic and logic unit.

2.8.2 Debug Flag (D)

The D flag is for debug only. Set to 0.

2.8.3 **Zero Flag (Z)**

The Z flag is set to 1 when an arithmetic operation resulted in 0; otherwise, 0.

2.8.4 Sign Flag (S)

The S flag is set to 1 when an arithmetic operation resulted in a negative value; otherwise, 0.

2.8.5 Register Bank Select Flag (B)

The register bank 0 is selected when the B flag is 0. The register bank 1 is selected when this flag is set to 1.

2.8.6 Overflow Flag (O)

The O flag is set to 1 when the operation resulted in an overflow; otherwise, 0.



2.8.7 Interrupt Enable Flag (I)

The I flag enables a maskable interrupt.

An interrupt is disabled when the I flag is set to 0, and are enabled when the I flag is set to 1. The I flag is set to 0 when an interrupt request is acknowledged.

2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0; USP is selected when the U flag is set to 1.

The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers. 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL, 3 bits wide, assigns processor interrupt priority levels from level 0 to level 7. If a requested interrupt has greater priority than IPL, the interrupt is enabled.

2.8.10 Reserved Bit

If necessary, set to 0. When read, the content is undefined.



3. Memory

3.1 R8C/22 Group

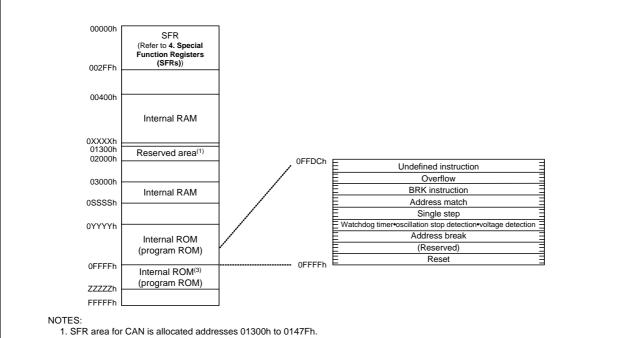
Figure 3.1 shows a Memory Map of R8C/22 Group. The R8C/22 Group has 1 Mbyte of address space from address 00000h to FFFFFh.

The internal ROM is allocated lower addresses, beginning with address 0FFFFh. For example, a 48-Kbyte internal ROM is allocated addresses 04000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 2.5-Kbyte internal RAM is allocated addresses 00400h to 00DFFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFR) are allocated addresses 00000h to 002FFh and 01300h to 0147Fh (SFR area for CAN). The peripheral function control registers are allocated here. All addresses within the SFR, which have nothing allocated are reserved for future user and cannot be accessed by users.



- 2. The blank regions are reserved. Do not access locations in these regions.
- 3. Do not use addresses 20000h to 23FFFh because these areas are used for the emulator debugger. Refer to 24. Notes on **Emulator Debugger**

Deat Novel on	Internal ROM			Internal RAM		
Part Number	Size	Address 0YYYYh	Address ZZZZZh	Size	Address 0XXXXh	Address 0SSSSh
R5F21226DFP, R5F21226JFP, R5F21226KFP	32 Kbytes	08000h	-	2 Kbytes	00BFFh	-
R5F21227DFP, R5F21227JFP, R5F21227KFP	48 Kbytes	04000h	-	2.5 Kbytes	00DFFh	-
R5F21228DFP, R5F21228JFP, R5F21228KFP	64 Kbytes	04000h	13FFFh	3 Kbytes	00FFFh	•
R5F2122AJFP, R5F2122AKFP	96 Kbytes	04000h	1BFFFh	5 Kbytes	00FFFh	037FFh
R5F2122CJFP, R5F2122CKFP	128 Kbytes	04000h	23FFFh	6 Kbytes	00FFFh	03BFFh

Figure 3.1 Memory Map of R8C/22 Group

3.2 R8C/23 Group

Figure 3.2 shows a Memory Map of R8C/23 Group. The R8C/23 Group has 1 Mbyte of address space from address 00000h to FFFFFh.

The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 48-Kbyte internal ROM is allocated addresses 04000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal ROM (data flash) is allocated addresses 02400h to 02BFFh.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 2.5-Kbyte internal RAM is allocated addresses 00400h to 00DFFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFR) are allocated addresses 00000h to 002FFh and 01300h to 0147Fh (SFR area for CAN). The peripheral function control registers are allocated them. All addresses within the SFR, which have nothing allocated are reserved for future use and cannot be accessed by users.

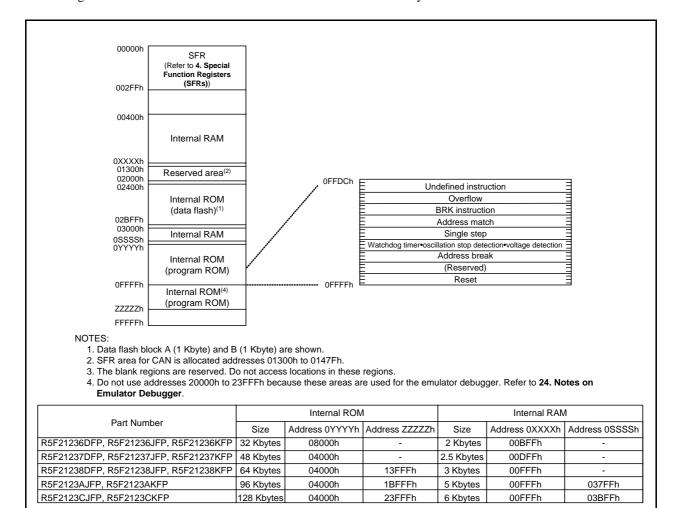


Figure 3.2 Memory Map of R8C/23 Group

4. Special Function Registers (SFRs)

An SFR (special function register) is a control register for a peripheral function. Table 4.1 to Table 4.13 list the SFR Information.

Table 4.1 SFR Information (1)⁽¹⁾

Address	Register	Symbol	After reset
0000h	, and the second		
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0	PM0	00h
0005h	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CM0	01101000b
0007h	System Clock Control Register 1	CM1	00100000b
0008h			
0009h			
000Ah	Protect Register	PRCR	00h
000Bh			
000Ch	Oscillation Stop Detection Register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Start Register	WDTS	XXh
000Fh	Watchdog Timer Control Register	WDC	00X11111b
0010h	Address Match Interrupt Register 0	RMAD0	00h
0011h	1		00h
0012h			00h
0013h	Address Match Interrupt Enable Register	AIER	00h
0014h	Address Match Interrupt Register 1	RMAD1	00h
0015h	· · ·		00h
0016h			00h
0017h			
0018h			
0019h			
001Ah			
001Bh			
001Ch	Count Source Protect Mode Register	CSPR	00h
			10000000b ⁽⁸⁾
001Dh			
001Eh			
001Fh			
0020h			
0021h			
0022h			
0023h	High-Speed On-Chip Oscillator Control Register 0	FRA0	00h
0024h	High-Speed On-Chip Oscillator Control Register 1	FRA1	When shipping
0025h	High-Speed On-Chip Oscillator Control Register 2	FRA2	00h
0026h	g		
	1	1	L
0030h			
0031h	Voltage Detection Register 1 ⁽²⁾	VCA1	00001000b
0032h	Voltage Detection Register 2 ⁽⁶⁾	VCA2	00h ⁽³⁾
			01000000b ⁽⁴⁾

0030h			
0031h	Voltage Detection Register 1 ⁽²⁾	VCA1	00001000b
0032h	Voltage Detection Register 2 ⁽⁶⁾	VCA2	00h ⁽³⁾
			01000000b ⁽⁴⁾
0033h			
0034h			
0035h			
0036h	Voltage Monitor 1 Circuit Control Register ⁽⁷⁾	VW1C	0000X000b ⁽³⁾
			0100X001b ⁽⁴⁾
0037h	Voltage Monitor 2 Circuit Control Register ⁽⁵⁾	VW2C	00h
0038h			
0039h			

003Fh X: Undefined

- The blank regions are reserved. Do not access locations in these regions.
- 2. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect this register.
- 3. The LVD0ON bit in the OFS register is set to 1.
- 4. Power-on reset, voltage monitor 1 reset or the LVD0ON bit in the OFS register is set to 0.
- 5. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect b2 and b3.
- 6. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect b7.
- 7. Software reset, the watchdog timer rest, and the voltage monitor 2 reset do not affect other than the b0 and b6.
- 8. The CSPROINI bit in the OFS register is 0.



SFR Information (2)⁽¹⁾ Table 4.2

A -1 -1	Dl-t	0	A 64 4
Address	Register	Symbol	After reset
0040h			
0041h			
0042h			
0043h	CAN0 Wake Up Interrupt Control Register	C01WKIC	XXXXX000b
0044h	CAN0 Successful Reception Interrupt Control Register	CORECIC	XXXXX000b
0045h	CANO Successful Transmission Interrupt Control Register	COTRMIC	XXXXX000b
0046h	CAN0 State/Error Interrupt Control Register	C01ERRIC	XXXXX000b
0047h			
0048h	Timer RD0 Interrupt Control Register	TRD0IC	XXXXX000b
0049h	Timer RD1 Interrupt Control Register	TRD1IC	XXXXX000b
004Ah	Timer RE Interrupt Control Register	TREIC	XXXXX000b
004Bh	· · · · · · · · · · · · · · · · · · ·	111213	1
004Ch			
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b XXXXXX000b
004En		SSUIC/IICIC	XXXXX000b
	SSU Interrupt Control Register/IIC Bus Interrupt Control Register ⁽²⁾	SSUIC/IICIC	XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX
0050h			
0051h	UART0 Transmit Interrupt Control Register	SOTIC	XXXXX000b
0052h	UART0 Receive Interrupt Control Register	SORIC	XXXXX000b
0053h	UART1 Transmit Interrupt Control Register	S1TIC	XXXXX000b
0054h	UART1 Receive Interrupt Control Register	S1RIC	XXXXX000b
0055h	INT2 Interrupt Control Register	INT2IC	XX00X000b
0056h	Timer RA Interrupt Control Register	TRAIC	XXXXX000b
0057h			
0058h	Timer RB Interrupt Control Register	TRBIC	XXXXX000b
0059h	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Ah	INT3 Interrupt Control Register	INT3IC	XX00X000b
005Bh	In the interrupt Control register	iitiolo	70.000.0000
005Ch		+	
005Dh	INT0 Interrupt Control Register	INTOIC	XX00X000b
	INTO Interrupt Control Negister	INTOIC	XX00X000D
005Eh			
005Fh			
0060h			
0061h			
0062h			
0063h			
0064h			
0065h			
0066h			
0067h			
0068h			
0069h			
006Ah			
006Bh			
006Ch			+
006Dh		+	+
006Eh			+
006En			
0070h			
0071h			
0072h			
0073h			
0074h			
0075h			
0076h			
0077h			
0078h			
0079h			
007Ah			
007Bh			
007Ch			+
007Dh		+	+
007Eh			+
007EH			+
007FII			

- The blank regions are reserved. Do not access locations in these regions.
 Selected by the IICSEL bit in the PMR register.

SFR Information (3)⁽¹⁾ Table 4.3

Address	Register	Symbol	After reset
0080h			1
0081h			
0082h			
0083h			
0084h			
0085h			-
0086h			_
0087h			_
0088h			_
0089h			_
008Ah			_
008Bh			
008Ch			_
008Dh			_
008Eh			
008Fh			
0090h			
0091h			
0092h			
0093h			+
0094h			+
0095h			
0096h			
0097h			
0098h			
0099h			
009Ah			
009Bh			
009Ch			
009Dh			
009Eh			
009Fh			
00A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
00A1h	UART0 Bit Rate Register	U0BRG	XXh
00A2h	UART0 Transmit Buffer Register	U0TB	XXh
00A3h			XXh
00A4h	UART0 Transmit/Receive Control Register 0	U0C0	00001000b
00A5h	UART0 Transmit/Receive Control Register 1	U0C1	00000010b
00A6h	UART0 Receive Buffer Register	U0RB	XXh
00A7h			XXh
00A8h	UART1 Transmit/Receive Mode Register	U1MR	00h
00A9h	UART1 Bit Rate Register	U1BRG	XXh
00AAh	UART1 Transmit Buffer Register	U1TB	XXh
00ABh			XXh
00ACh	UART1 Transmit/Receive Control Register 0	U1C0	00001000b
00ADh	UART1 Transmit/Receive Control Register 1	U1C1	0000010b
00AEh	UART1 Receive Buffer Register	U1RB	XXh
00AFh	1		XXh
00B0h			
00B1h			1
00B2h			1
00B3h			+
00B4h			+
00B5h			+
00B6h	<u> </u>		+
00B7h			+
00B8h	SS Control Register H/IIC Bus Control Register 1 ⁽²⁾	SSCRH/ICCR1	00h
00B9h	SS Control Register L/IIC Bus Control Register 2 ⁽²⁾	SSCRL/ICCR2	01111101b
		SSMR/ICMR	
00BAh	SS Mode Register/IIC Bus Mode Register 1(2)		00011000b
00BBh	SS Enable Register/IIC Bus Interrupt Enable Register ⁽²⁾	SSER/ICIER	00h
00BCh	SS Status Register/IIC Bus Status Register ⁽²⁾	SSSR/ICSR	00h/0000X000b
	(4)	CCMDQ/CAD	00h
00BDh	SS Mode Register 2/Slave Address Register ⁽²⁾	SSMR2/SAR	00h
	SS Mode Register 2/Slave Address Register ⁽²⁾ SS Transmit Data Register/IIC Bus Transmit Data Register ⁽²⁾	SSTDR/ICDRT	FFh

- The blank regions are reserved. Do not access locations in these regions.
 Selected by the IICSEL bit in the PMR register.

SFR Information (4)⁽¹⁾ Table 4.4

00C0h 00C1h 00C2h 00C3h 00C4h 00C5h	Register A/D Register	Symbol AD	After reset XXh XXh
00C1h 00C2h 00C3h 00C4h			
00C2h 00C3h 00C4h			
00C3h 00C4h			
00C4h			
00C6h			
00C7h			
00C8h			
00C9h			
00CAh			
00CBh			
00CCh			
00CDh			
00CEh			
00CFh			
00D0h			
00D1h			
00D2h			
00D3h		1.500.00	
00D4h	A/D Control Register 2	ADCON2	00h
00D5h			
00D6h	A/D Control Register 0	ADCON0	00h
00D7h	A/D Control Register 1	ADCON1	00h
00D8h			
00D9h			
00DAh			
00DBh			
00DCh			
00DDh			
00DEh			
00DFh			
00E0h	Port P0 Register	P0	XXh
00E1h	Port P1 Register	P1	XXh
00E2h	Port P0 Direction Register	PD0	00h
00E3h	Port P1 Direction Register	PD1	00h
00E4h	Port P2 Register	P2	XXh
00E5h	Port P3 Register	P3	XXh
00E6h	Port P2 Direction Register	PD2	00h
	Port P2 Direction Register		
00E7h	Port P3 Direction Register	PD3	00h
00E8h	Port P4 Register	P4	XXh
00E9h			
00EAh	Port P4 Direction Register	PD4	00h
00EBh			
00ECh	Port P6 Register	P6	XXh
00EDh			
00EEh	Port P6 Direction Register	PD6	00h
00EFh			
00F0h			
00F1h			
00F2h			
00F3h			
00F4h			
00F5h	UART1 Function Select Register	U1SR	XXh
00F6h		2.3	
00F7h		+	
00F8h	Port Mode Register	PMR	00h
00F9h	External Input Enable Register	INTEN	00h
00FAh	INT Input Filter Select Register	INTEN	00h
	Key Input Enable Register	KIEN	00h
00FBh	Rey Input Effable Register	PUR0	
00FCh 00FDh	Pull-Up Control Register 0		00h
OOFDh	Pull-Up Control Register 1	PUR1	XX00XX00b
00FEh	1		

NOTE:

SFR Information (5)⁽¹⁾ Table 4.5

			1
Address	Register	Symbol	After reset
0100h	Timer RA Control Register	TRACR	00h
0101h	Timer RA I/O Control Register	TRAIOC	00h
0102h	Timer RA Mode Register	TRAMR	00h
0103h	Timer RA Prescaler Register	TRAPRE	FFh
0104h	Timer RA Register	TRA	FFh
0105h	Time IX Register	TIVA	+'''
		1,000	1
0106h	LIN Control Register	LINCR	00h
0107h	LIN Status Register	LINST	00h
0108h	Timer RB Control Register	TRBCR	00h
0109h	Timer RB One-Shot Control Register	TRBOCR	00h
010Ah	Timer RB I/O Control Register	TRBIOC	00h
010An	Timer RB Mode Register	TRBMR	
			00h
010Ch	Timer RB Prescaler Register	TRBPRE	FFh
010Dh	Timer RB Secondary Register	TRBSC	FFh
010Eh	Timer RB Primary	TRBPR	FFh
010Fh		1	
0110h			+
		-	
0111h			
0112h			
0113h			
0114h		1	1
0115h		†	+
0116h		+	+
		+	+
0117h		<u> </u>	
0118h	Timer RE Counter Data Register	TRESEC	00h
0119h	Timer RE Compare Data Register	TREMIN	00h
011Ah		1	
011Bh			
011Ch	Timer RE Control Register 1	TRECR1	00h
	Timer RE Control Register 1		
011Dh	Timer RE Control Register 2	TRECR2	00h
011Eh	Timer RE Count Source Select Register	TRECSR	00001000b
011Fh			
0120h			1
0121h		+	-
		+	
0122h			
0123h			
0124h			
0125h			
0126h			1
0127h		-	+
		+	
0128h			
0129h			
012Ah			
012Bh			
012Ch			
012Dh		+	+
		+	+
012Eh		 	
012Fh		<u> </u>	
0130h			
0131h		1	
0132h		+	
0132h		+	+
			_
0134h			
0135h			
0136h			
0137h	Timer RD Start Register	TRDSTR	11111100b
0138h	Timer RD Mode Register	TRDMR	00001110b
	Timer RD PWM Mode Register		10001110b
0139h		TRDPMR	
013Ah	Timer RD Function Control Register	TRDFCR	10000000b
013Bh	Timer RD Output Master Enable Register 1	TRDOER1	FFh
013Ch	Timer RD Output Master Enable Register 2	TRDOER2	01111111b
013Dh	Timer RD Output Control Register	TRDOCR	00h
	Timer RD Digital Filter Function Select Register 0	I TRUDEO	
013Eh 013Fh	Timer RD Digital Filter Function Select Register 0 Timer RD Digital Filter Function Select Register 1	TRDDF0 TRDDF1	00h 00h

NOTE:

SFR Information (6)⁽¹⁾ Table 4.6

Address	
0141h Timer RD I/O Control Register A0 TRDIORA0 10001000b 0142h Timer RD I/O Control Register C0 TRDIORC0 10001000b 0143h Timer RD Status Register 0 TRDSR0 11100000b 0144h Timer RD Interrupt Enable Register 0 TRDIER0 11100000b 0144h Timer RD Interrupt Enable Register 0 TRDIER0 11110000b 0145h Timer RD PWM Mode Output Level Control Register 0 TRDO 00h 0146h Timer RD Counter 0 TRDO 00h 0147h 00h 00h 00h 0147h Timer RD General Register A0 TRDGRA0 FFh 0149h Timer RD General Register B0 TRDGRB0 FFh 014Dh Timer RD General Register C0 TRDGRC0 FFh 014Dh Timer RD General Register D0 TRDGRD0 FFh 014Fh Timer RD Control Register 1 TRDGR1 100h 0150h Timer RD Control Register A1 TRDIORA1 10001000b 0152h Timer RD Interrupt Enable Register 1 TRDIGR1 11100000b<	
O142h	
0143h Timer RD Status Register 0 TRDSR0 11100000b 0144h Timer RD Interrupt Enable Register 0 TRDIER0 11100000b 0145h Timer RD PWM Mode Output Level Control Register 0 TRDPOCR0 11111000b 0146h Timer RD Counter 0 TRD0 00h 0147h O148h Timer RD General Register A0 FFh 0149h Timer RD General Register B0 TRDGRA0 FFh 0148h Timer RD General Register C0 TRDGRB0 FFh 014Bh Timer RD General Register C0 TRDGRC0 FFh 014Dh Timer RD General Register D0 TRDGRD0 FFh 014Fh Timer RD Control Register A1 TRDCR1 O0h 0151h Timer RD I/O Control Register A1 TRDIORC1 10001000b 0152h Timer RD I/O Control Register C1 TRDIORC1 11000000b 0154h Timer RD Interrupt Enable Register 1 TRDICR1 11100000b 0155h Timer RD PWM Mode Output Level Control Register 1 TRDPOCR1 111111000b 0158h Timer RD General Register A1 </td <td></td>	
0144h Timer RD Interrupt Enable Register 0 TRDIER0 11100000b 0145h Timer RD PWM Mode Output Level Control Register 0 TRDPOCR0 11111000b 0146h Timer RD Counter 0 TRD0 00h 0147h Timer RD General Register A0 TRDGRA0 FFh 0149h FFh FFh FFh 014Bh Timer RD General Register B0 TRDGRB0 FFh 014Bh Timer RD General Register C0 TRDGRC0 FFh 014Ch Timer RD General Register D0 TRDGRD0 FFh 014Fh Timer RD General Register D0 TRDGRD0 FFh 014Fh Timer RD Control Register A1 TRDCR1 00h 0150h Timer RD I/O Control Register A1 TRDIORA1 10001000b 0153h Timer RD Status Register 1 TRDSR1 11000000b 0154h Timer RD Interrupt Enable Register 1 TRDIER1 11110000b 0155h Timer RD Counter 1 TRDPOCR1 11111000b 0157h Timer RD General Register A1 TRDGRA1 FFh	
0145h Timer RD PWM Mode Output Level Control Register 0 TRDPOCR0 11111000b 0146h Timer RD Counter 0 TRD0 00h 0147h TRDGRA0 FFh 0148h Timer RD General Register A0 TRDGRA0 FFh 0149h FFh FFh 0149h Timer RD General Register B0 TRDGRB0 FFh 014Bh FFh FFh 014Ch Timer RD General Register C0 TRDGRC0 FFh 014Dh FFh FFh 014Eh Timer RD General Register D0 TRDGRD0 FFh 014Fh Timer RD Control Register A1 TRDGRA1 100010000b 0151h Timer RD I/O Control Register A1 TRDIORA1 10001000b 0152h Timer RD I/O Control Register C1 TRDIORC1 10001000b 0153h Timer RD Status Register A1 TRDSR1 11100000b 0154h Timer RD I/O Control Register A1 TRDIER1 11110000b 0155h Timer RD PWM Mode Output Level Control Register 1 TRDPOCR1 111111000b	
0146h Timer RD Counter 0 TRD0 00h 0147h 0148h Timer RD General Register A0 TRDGRA0 FFh 0149h TRDGRB0 FFh FFh 014Ah Timer RD General Register B0 TRDGRB0 FFh 014Bh Timer RD General Register C0 TRDGRC0 FFh 014Dh FFh FFh FFh 014Eh Timer RD General Register D0 TRDGRD0 FFh 0150h Timer RD Control Register A1 TRDCR1 00h 0151h Timer RD I/O Control Register A1 TRDIORA1 10001000b 0152h Timer RD Status Register A1 TRDIORC1 10001000b 0153h Timer RD Status Register A1 TRDIER1 11100000b 0154h Timer RD Interrupt Enable Register A1 TRDPOCR1 11111000b 0156h Timer RD Counter A TRDI 00h 0157h Timer RD General Register A1 TRDGRA1 FFh 0157h Timer RD General Register A1 TRDGRA1 FFh 0159h Timer RD G	
0147h 0148h Timer RD General Register A0 TRDGRA0 FFh 0149h Timer RD General Register B0 FFh FFh 014Ah Timer RD General Register B0 TRDGRB0 FFh 014Bh Timer RD General Register C0 TRDGRC0 FFh 014Dh FFh FFh FFh 014Dh Timer RD General Register D0 TRDGRD0 FFh 014Fh Timer RD Control Register 1 TRDCR1 00h 0150h Timer RD Control Register A1 TRDIORA1 10001000b 0151h Timer RD I/O Control Register C1 TRDIORC1 10001000b 0153h Timer RD Status Register C1 TRDSR1 11000000b 0154h Timer RD Interrupt Enable Register 1 TRDER1 111100000b 0156h Timer RD Counter 1 TRDPOCR1 11111000b 0157h Timer RD General Register A1 TRDGRA1 FFh 0159h Timer RD General Register A1 TRDGRA1 FFh	
0148h Timer RD General Register A0 TRDGRA0 FFh 0149h Timer RD General Register B0 TRDGRB0 FFh 014Bh Timer RD General Register C0 TRDGRC0 FFh 014Ch Timer RD General Register C0 TRDGRC0 FFh 014Dh Timer RD General Register D0 TRDGRD0 FFh 014Fh Timer RD Control Register 1 TRDCR1 00h 0151h Timer RD I/O Control Register A1 TRDIORA1 10001000b 0152h Timer RD I/O Control Register C1 TRDIORC1 10001000b 0153h Timer RD Status Register 1 TRDSR1 11000000b 0154h Timer RD Interrupt Enable Register 1 TRDIER1 11110000b 0155h Timer RD Counter 1 TRDPOCR1 11111000b 0157h Timer RD General Register A1 TRDGRA1 FFh 0159h Timer RD General Register A1 TRDGRA1 FFh	
O149h	
014Ah Timer RD General Register B0 TRDGRB0 FFh 014Bh Timer RD General Register C0 TRDGRC0 FFh 014Dh Timer RD General Register C0 TRDGRC0 FFh 014Dh Timer RD General Register D0 TRDGRD0 FFh 014Fh Timer RD Control Register 1 TRDCR1 00h 0150h Timer RD I/O Control Register A1 TRDIORA1 10001000b 0152h Timer RD I/O Control Register C1 TRDIORC1 10001000b 0153h Timer RD Status Register 1 TRDIER1 11000000b 0154h Timer RD Interrupt Enable Register 1 TRDIER1 11110000b 0155h Timer RD PWM Mode Output Level Control Register 1 TRDPOCR1 111111000b 0157h Timer RD General Register A1 TRDGRA1 FFh 0159h Timer RD General Register A1 TRDGRA1 FFh	
O14Bh	
014Ch Timer RD General Register C0 TRDGRC0 FFh 014Dh Timer RD General Register D0 TRDGRD0 FFh 014Fh Timer RD General Register D0 TRDGRD0 FFh 014Fh Timer RD Control Register 1 TRDCR1 00h 0150h Timer RD I/O Control Register A1 TRDIORA1 10001000b 0152h Timer RD I/O Control Register C1 TRDIORC1 10001000b 0153h Timer RD Status Register 1 TRDSR1 11000000b 0154h Timer RD Interrupt Enable Register 1 TRDIER1 111100000b 0155h Timer RD PWM Mode Output Level Control Register 1 TRDPOCR1 111111000b 0156h Timer RD Counter 1 TRD1 00h 0157h 00h 0158h Timer RD General Register A1 TRDGRA1 FFh 0159h Timer RD General Register A1 TRDGRA1 FFh	
O14Dh	
014Eh Timer RD General Register D0 TRDGRD0 FFh 014Fh Timer RD Control Register 1 TRDCR1 00h 0150h Timer RD Control Register 1 TRDIORA1 10001000b 0151h Timer RD I/O Control Register C1 TRDIORC1 10001000b 0152h Timer RD Status Register C1 TRDSR1 11000000b 0153h Timer RD Status Register 1 TRDIER1 11100000b 0154h Timer RD Interrupt Enable Register 1 TRDIER1 11110000b 0155h Timer RD PWM Mode Output Level Control Register 1 TRDPOCR1 11111000b 0156h Timer RD Counter 1 00h 00h 0157h Timer RD General Register A1 TRDGRA1 FFh 0159h Timer RD General Register A1 TRDGRA1 FFh	
0150h Timer RD Control Register 1 TRDCR1 00h 0151h Timer RD I/O Control Register A1 TRDIORA1 10001000b 0152h Timer RD I/O Control Register C1 TRDIORC1 10001000b 0153h Timer RD Status Register 1 TRDSR1 11000000b 0154h Timer RD Interrupt Enable Register 1 TRDIER1 11100000b 0155h Timer RD PWM Mode Output Level Control Register 1 TRDPOCR1 11111000b 0156h Timer RD Counter 1 TRD1 00h 0158h Timer RD General Register A1 TRDGRA1 FFh 0159h FFh FFh	
0151h Timer RD I/O Control Register A1 TRDIORA1 10001000b 0152h Timer RD I/O Control Register C1 TRDIORC1 10001000b 0153h Timer RD Status Register 1 TRDSR1 11000000b 0154h Timer RD Interrupt Enable Register 1 TRDIER1 11100000b 0155h Timer RD PWM Mode Output Level Control Register 1 TRDPOCR1 11111000b 0156h Timer RD Counter 1 TRD1 00h 0157h 00h 00h 0158h Timer RD General Register A1 TRDGRA1 FFh 0159h FFh FFh	
0152h Timer RD I/O Control Register C1 TRDIORC1 10001000b 0153h Timer RD Status Register 1 TRDSR1 11000000b 0154h Timer RD Interrupt Enable Register 1 TRDIER1 11100000b 0155h Timer RD PWM Mode Output Level Control Register 1 TRDPOCR1 11111000b 0156h Timer RD Counter 1 TRD1 00h 0157h 00h 00h 0158h Timer RD General Register A1 TRDGRA1 FFh 0159h FFh FFh	
0153h Timer RD Status Register 1 TRDSR1 11000000b 0154h Timer RD Interrupt Enable Register 1 TRDIER1 11100000b 0155h Timer RD PWM Mode Output Level Control Register 1 TRDPOCR1 11111000b 0156h Timer RD Counter 1 TRD1 00h 0157h 00h 00h 00h 0158h Timer RD General Register A1 TRDGRA1 FFh 0159h FFh FFh	
0153h Timer RD Status Register 1 TRDSR1 11000000b 0154h Timer RD Interrupt Enable Register 1 TRDIER1 11100000b 0155h Timer RD PWM Mode Output Level Control Register 1 TRDPOCR1 11111000b 0156h Timer RD Counter 1 TRD1 00h 0157h 00h 00h 00h 0158h Timer RD General Register A1 TRDGRA1 FFh 0159h FFh FFh	
0154h Timer RD Interrupt Enable Register 1 TRDIER1 11100000b 0155h Timer RD PWM Mode Output Level Control Register 1 TRDPOCR1 11111000b 0156h Timer RD Counter 1 TRD1 00h 0157h 00h 00h 00h 0158h Timer RD General Register A1 TRDGRA1 FFh 0159h FFh FFh	
0156h Timer RD Counter 1 00h 0157h 00h 0158h Timer RD General Register A1 TRDGRA1 0159h FFh	
0157h 00h 0158h Timer RD General Register A1 TRDGRA1 FFh 0159h FFh FFh	
0158h Timer RD General Register A1 TRDGRA1 FFh 0159h FFh FFh	
0159h FFh	
015Ah Timer RD General Register B1 TRDGRB1 FFh	
9	
015Bh FFh	
015Ch Timer RD General Register C1 TRDGRC1 FFh	
015Dh FFh	
015Eh Timer RD General Register D1 TRDGRD1 FFh	
015Fh FFh 0160h	
0161h	
0162h 0163h	
0164h	
0165h	
0166h	
0167h	
0168h	
0169h	
016Ah	
016Bh	
016Ch	
016Dh	
016Eh	
016Fh	
0170h	
0171h	
0172h	
0173h	
0174h	
0175h	
0176h	
0177h	
0178h	
0179h	
017Ah	
017Bh	
017Ch	
017Dh	
017Eh	
017Fh	

NOTE:

SFR Information (7)⁽¹⁾ Table 4.7

Address	Register	Symbol	After reset
0180h	Ü	,	
0181h			
0182h			
0183h			
0184h			
0185h			
0186h			
0187h			
0188h 0189h			
018Ah			
018Bh			
018Ch			
018Dh			
018Eh			
018Fh			
0190h			
0191h			
0192h			
0193h			
0194h			
0195h			
0196h 0197h			
0197h			
0199h			
019Ah			
019Bh			
019Ch			
019Dh			
019Eh			
019Fh			
01A0h			
01A1h			
01A2h			
01A3h 01A4h			
01A4H			
01A6h			
01A7h			
01A8h			
01A9h			
01AAh			
01ABh			
01ACh			
01ADh			
01AEh			
01AFh			
01B0h			
01B1h 01B2h			
01B3h	Flash Memory Control Register 4	FMR4	01000000b
01B4h	ac		0.000000
01B5h	Flash Memory Control Register 1	FMR1	1000000Xb
01B6h	<u> </u>		
01B7h	Flash Memory Control Register 0	FMR0	00000001b
01B8h			
01B9h			
01BAh			
01BBh			
04505			†
01FDh 01FEh			
01FEh			
Villadefined			

NOTE:

SFR Information (8)⁽¹⁾ Table 4.8

1300h CAN0 Message Control Register 0 COMCTL0 00h 1301h CAN0 Message Control Register 1 COMCTL1 00h 1302h CAN0 Message Control Register 2 COMCTL2 00h 1303h CAN0 Message Control Register 3 COMCTL3 00h 1304h CAN0 Message Control Register 4 COMCTL4 00h 1305h CAN0 Message Control Register 5 COMCTL5 00h 1306h CAN0 Message Control Register 6 COMCTL6 00h 1307h CAN0 Message Control Register 7 COMCTL7 00h 1308h CAN0 Message Control Register 8 COMCTL8 00h 1309h CAN0 Message Control Register 9 COMCTL9 00h 130Ah CAN0 Message Control Register 10 COMCTL10 00h	er reset
1301h CAN0 Message Control Register 1 C0MCTL1 00h 1302h CAN0 Message Control Register 2 C0MCTL2 00h 1303h CAN0 Message Control Register 3 C0MCTL3 00h 1304h CAN0 Message Control Register 4 C0MCTL4 00h 1305h CAN0 Message Control Register 5 C0MCTL5 00h 1306h CAN0 Message Control Register 6 C0MCTL6 00h 1307h CAN0 Message Control Register 7 C0MCTL7 00h 1308h CAN0 Message Control Register 8 C0MCTL8 00h 1309h CAN0 Message Control Register 9 C0MCTL9 00h 130Ah CAN0 Message Control Register 10 C0MCTL10 00h	
1302h CAN0 Message Control Register 2 COMCTL2 00h 1303h CAN0 Message Control Register 3 COMCTL3 00h 1304h CAN0 Message Control Register 4 COMCTL4 00h 1305h CAN0 Message Control Register 5 COMCTL5 00h 1306h CAN0 Message Control Register 6 COMCTL6 00h 1307h CAN0 Message Control Register 7 COMCTL7 00h 1308h CAN0 Message Control Register 8 COMCTL8 00h 1309h CAN0 Message Control Register 9 COMCTL9 00h 130Ah CAN0 Message Control Register 10 COMCTL10 00h	
1303h CAN0 Message Control Register 3 C0MCTL3 00h 1304h CAN0 Message Control Register 4 C0MCTL4 00h 1305h CAN0 Message Control Register 5 C0MCTL5 00h 1306h CAN0 Message Control Register 6 C0MCTL6 00h 1307h CAN0 Message Control Register 7 C0MCTL7 00h 1308h CAN0 Message Control Register 8 C0MCTL8 00h 1309h CAN0 Message Control Register 9 C0MCTL9 00h 130Ah CAN0 Message Control Register 10 C0MCTL10 00h	
1304h CAN0 Message Control Register 4 COMCTL4 00h 1305h CAN0 Message Control Register 5 COMCTL5 00h 1306h CAN0 Message Control Register 6 COMCTL6 00h 1307h CAN0 Message Control Register 7 COMCTL7 00h 1308h CAN0 Message Control Register 8 COMCTL8 00h 1309h CAN0 Message Control Register 9 COMCTL9 00h 130Ah CAN0 Message Control Register 10 COMCTL10 00h	
1305h CAN0 Message Control Register 5 C0MCTL5 00h 1306h CAN0 Message Control Register 6 C0MCTL6 00h 1307h CAN0 Message Control Register 7 C0MCTL7 00h 1308h CAN0 Message Control Register 8 C0MCTL8 00h 1309h CAN0 Message Control Register 9 C0MCTL9 00h 130Ah CAN0 Message Control Register 10 C0MCTL10 00h	
1306h CAN0 Message Control Register 6 COMCTL6 00h 1307h CAN0 Message Control Register 7 COMCTL7 00h 1308h CAN0 Message Control Register 8 COMCTL8 00h 1309h CAN0 Message Control Register 9 COMCTL9 00h 130Ah CAN0 Message Control Register 10 COMCTL10 00h	
1307h CAN0 Message Control Register 7 COMCTL7 00h 1308h CAN0 Message Control Register 8 COMCTL8 00h 1309h CAN0 Message Control Register 9 COMCTL9 00h 130Ah CAN0 Message Control Register 10 COMCTL10 00h	
1308h CAN0 Message Control Register 8 C0MCTL8 00h 1309h CAN0 Message Control Register 9 C0MCTL9 00h 130Ah CAN0 Message Control Register 10 C0MCTL10 00h	
1309h CAN0 Message Control Register 9 C0MCTL9 00h 130Ah CAN0 Message Control Register 10 C0MCTL10 00h	
130Ah CAN0 Message Control Register 10 C0MCTL10 00h	
120Ph CANO Magazara Control Paginter 11	
130Ch CAN0 Message Control Register 12 C0MCTL12 00h	
130Dh CAN0 Message Control Register 13 C0MCTL13 00h	
130Eh CAN0 Message Control Register 14 C0MCTL14 00h	
130Fh CAN0 Message Control Register 15 C0MCTL15 00h	
1310h CAN0 Control Register C0CTLR X0000001)
1311h XX0X0000	
1312h CANO Status Register COSTR O0h	
1313h X0000001)
1314h CANO Slot Status Register COSSTR 00h	-
1315h OANO GIOL GIALUS REGISTER 6007	
1316h CAN0 Interrupt Control Register COICR 00h	-
1317h CANO Interrupt Control Register Color Other	
1318h CAN0 Extended ID Register COIDR 00h	
1319h CANO Extended ib Register COIDR 00h	
131Ah CAN0 Configuration Register COCONR XXh	
131Bh ZANO Connigulation Register Coconk XXII	
131Eh	
131Fh	
1320h	
1321h	
1322h	
1323h	
1324h	
1325h	
1326h	
1327h	
1328h	
1329h	
132Ah	
132Bh	
132Ch	-
132Dh	
132Eh	
132Fh	
1330h	
1331h	
1332h	-
1333h	
1334h	
1335h	
1336h	
1336h 1337h	
1337h	
1337h 1338h	
1337h 1338h 1339h	
1337h 1338h 1339h 133Ah	
1337h 1338h 1339h 133Ah 133Bh	
1337h 1338h 1339h 133Ah 133Bh 133Ch	
1337h 1338h 1339h 133Ah 133Bh 133Ch 133Dh	
1337h 1338h 1339h 133Ah 133Bh 133Ch	

NOTE:

SFR Information (9)⁽¹⁾ Table 4.9

Address	Register	Symbol	After reset
1340h	Register	Sylfibol	Allei Teset
1341h			
	CANO Appartures Filter Current Degister	COAFC	VVb
1342h	CAN0 Acceptance Filter Support Register	C0AFS	XXh
1343h			XXh
1344h			
1345h			
1346h			
1347h			
1348h			
1349h			
134Ah			
134Bh			
134Ch			
134Dh			
134Eh			
134Fh			
1350h			
1351h			
1352h			
1353h			
1354h			
1355h			
1356h			
1357h			
1358h			
1359h			
135Ah			
135Bh			
135Ch			
135Dh			
135Eh			
135Fh	CANO Clock Select Register	CCLKR	00h
1360h	CANO Clock Select Register CANO Slot 0: Identifier/DLC		XXh
1361h			XXh
1362h			XXh
1363h			XXh
1364h			XXh
1365h			XXh
1366h	CAN0 Slot 0: Data Field		XXh
1367h	or the diet of Bata Field		XXh
1368h			XXh
1369h			XXh
136Ah			XXh
136Bh			XXh
136Bh			XXh
136Dh			XXh
	CANO Slot 0: Timo Stomp	-	XXh
136Eh 136Fh	CAN0 Slot 0: Time Stamp		
	CANO Slot 1: Identifier/DLC		XXh
1370h	CAN0 Slot 1: Identifier/DLC		XXh
1371h			XXh
1372h			XXh
1373h			XXh
1374h			XXh
1375h	0.4.1.2.2.1.4.1.2.1.2		XXh
1376h	CAN0 Slot 1: Data Field		XXh
1377h			XXh
1378h			XXh
1379h			XXh
137Ah			XXh
137Bh			XXh
137Ch			XXh
137Dh			XXh
137Eh	CAN0 Slot 1: Time Stamp		XXh
137Fh			XXh
			1

NOTE:

SFR Information (10)⁽¹⁾ **Table 4.10**

Address	Register	Symbol	After reset
1380h	CAN0 Slot 2: Identifier/DLC		XXh
1381h			XXh
1382h			XXh
1383h			XXh
1384h			XXh
1385h			XXh
1386h	CAN0 Slot 2: Data Field		XXh
1387h			XXh
1388h			XXh
1389h			XXh
138Ah			XXh
138Bh			XXh
138Ch			XXh
138Dh			XXh
138Eh	CAN0 Slot 2: Time Stamp		XXh
138Fh			XXh
1390h	CAN0 Slot 3: Identifier/DLC		XXh
1391h			XXh
1392h			XXh
1393h			XXh
1394h			XXh
1395h	000000000000000000000000000000000000000		XXh
1396h	CAN0 Slot 3: Data Field		XXh
1397h			XXh
1398h	-		XXh
1399h			XXh
139Ah 139Bh			XXh
	-		XXh
139Ch 139Dh	-		XXh XXh
1	CANO Clot 2: Time Stomp		XXh
139Eh 139Fh	CAN0 Slot 3: Time Stamp		XXh
13A0h	CAN0 Slot 4: Identifier/DLC		XXh
13A1h	CANO SIOI 4. Identiliei/DEC		XXh
13A2h	-		XXh
13A3h	-		XXh
13A4h			XXh
13A5h	-		XXh
13A6h	CAN0 Slot 4: Data Field		XXh
13A7h	- C. W. O. O. C. T. D. G. G. T. D. G. G. T. D. G.		XXh
13A8h			XXh
13A9h	†		XXh
13AAh	1		XXh
13ABh	1		XXh
13ACh	1		XXh
13ADh	1		XXh
13AEh	CAN0 Slot 4: Time Stamp		XXh
13AFh	<u> </u>		XXh
13B0h	CAN0 Slot 5: Identifier/DLC		XXh
13B1h			XXh
13B2h			XXh
13B3h			XXh
13B4h			XXh
13B5h			XXh
13B6h	CAN0 Slot 5: Data Field		XXh
13B7h			XXh
13B8h			XXh
13B9h			XXh
13BAh			XXh
13BBh			XXh
13BCh			XXh
13BDh			XXh
13BEh	CAN0 Slot 5: Time Stamp		XXh
13BFh			XXh

NOTE:

SFR Information (11)⁽¹⁾ **Table 4.11**

Address	` '	Cumbal	After reset
Address 13C0h	Register CAN0 Slot 6: Identifier/DLC	Symbol	XXh
13C1h	CANO SIOLO. Identilier/DEC		XXh
	-		XXh
13C2h	-		
13C3h			XXh
13C4h			XXh
13C5h	LOANIO OL LO DIL FILL		XXh
13C6h	CAN0 Slot 6: Data Field		XXh
13C7h			XXh
13C8h			XXh
13C9h			XXh
13CAh			XXh
13CBh			XXh
13CCh			XXh
13CDh			XXh
13CEh	CAN0 Slot 6: Time Stamp		XXh
13CFh			XXh
13D0h	CAN0 Slot 7: Identifier/DLC		XXh
13D1h			XXh
13D2h			XXh
13D3h			XXh
13D4h			XXh
13D5h			XXh
13D6h	CAN0 Slot 7: Data Field		XXh
13D7h			XXh
13D8h			XXh
13D9h			XXh
13DAh			XXh
13DBh			XXh
13DCh			XXh
13DDh			XXh
13DEh	CAN0 Slot 7: Time Stamp		XXh
13DFh	'		XXh
13E0h	CAN0 Slot 8: Identifier/DLC		XXh
13E1h			XXh
13E2h			XXh
13E3h			XXh
13E4h	1		XXh
13E5h	1		XXh
13E6h	CAN0 Slot 8: Data Field		XXh
13E7h	0.11.10 0.01.01 2.11.01.1		XXh
13E8h	1		XXh
13E9h			XXh
13EAh	1		XXh
13EBh	1		XXh
13ECh	-		XXh
13EDh	-		XXh
13EEh	CAN0 Slot 8: Time Stamp		XXh
13EFh	Onivo olot o. Time Stamp		XXh
13F0h	CANO Slot 9: Identifier/DLC		XXh
	OANO SIOL 3. IDENTINE/DEC		
13F1h	-		XXh
13F2h	4		XXh
13F3h	-		XXh
13F4h	-		XXh
13F5h	LOANIO CIELO: Dete Field		XXh
13F6h	CAN0 Slot 9: Data Field		XXh
13F7h	-		XXh
13F8h			XXh
13F9h			XXh
13FAh			XXh
13FBh			XXh
13FCh			XXh
40EDI			XXh
13FDh			
13FDh 13FEh 13FFh	CAN0 Slot 9: Time Stamp		XXh XXh

NOTE:

SFR Information (12)⁽¹⁾ **Table 4.12**

Address	Register	Symbol	After reset
1400h	CANO Slot 10: Identifier/DLC	- j	XXh
1401h			XXh
1402h			XXh
1403h			XXh
1404h			XXh
1405h			XXh
1406h	CAN0 Slot 10: Data Field		XXh
1407h			XXh
1408h			XXh
1409h			XXh
140Ah			XXh
140Bh			XXh
140Ch			XXh
140Dh			XXh
140Eh	CAN0 Slot 10: Time Stamp		XXh
140Fh			XXh
1410h	CAN0 Slot 11: Identifier/DLC		XXh
1411h			XXh
1412h			XXh
1413h			XXh
1414h			XXh
1415h			XXh
1416h	CAN0 Slot 11: Data Field		XXh
1417h			XXh
1418h			XXh
1419h			XXh
141Ah			XXh
141Bh			XXh
141Ch			XXh
141Dh			XXh
141Eh	CAN0 Slot 11: Time Stamp		XXh
141Fh			XXh
1420h	CAN0 Slot 12: Identifier/DLC		XXh
1421h			XXh
1422h			XXh
1423h			XXh
1424h			XXh
1425h			XXh
1426h	CAN0 Slot 12: Data Field		XXh
1427h			XXh
1428h			XXh
1429h			XXh
142Ah			XXh
142Bh			XXh
142Ch			XXh
142Dh	LOANIO CLA 40 Time Cr		XXh
142Eh	CAN0 Slot 12: Time Stamp		XXh
142Fh			XXh
1430h	CAN0 Slot 13: Identifier/DLC		XXh
1431h			XXh
1432h			XXh
1433h			XXh
1434h			XXh
1435h	LOANO Clat 12: Data Field		XXh
1436h	CAN0 Slot 13: Data Field		XXh
1437h			XXh
1438h			XXh
1439h			XXh
143Ah			XXh
143Bh			XXh
143Ch			XXh
143Dh	LOANIO CI-t 40: Time Change		XXh
143Eh	CAN0 Slot 13: Time Stamp		XXh
143Fh			XXh

NOTE:

SFR Information (13)⁽¹⁾ **Table 4.13**

Address	Register	Symbol	After reset
1440h	CANO Slot 14: Identifier/DLC	3,	XXh
1441h			XXh
1442h	1		XXh
1443h	1		XXh
1444h	†		XXh
1445h	+		XXh
1446h	CAN0 Slot 14: Data Field		XXh
1447h	Oniversity: Balanticia		XXh
1448h	-		XXh
1449h	-		XXh
144Ah	-		XXh
144Bh	-		XXh
144Ch	-		XXh
144Dh	-		XXh
144Eh	CAN0 Slot 14: Time Stamp		XXh
144En	CANO SIOU 14. Time Stamp		XXh
144Ffi 1450h	CAN0 Slot 15: Identifier/DLC		XXh
1450fi 1451h	CANO SIOU 13. Identilie/DEC		XXh
1451h	4		XXh
1452H	4		XXh
1453h 1454h	4		XXh
	4		XXh
1455h 1456h	CAN0 Slot 15: Data Field		
1456h 1457h	CANU Slot 15: Data Field		XXh
			XXh XXh
1458h	4		
1459h			XXh
145Ah	1		XXh
145Bh			XXh
145Ch	1		XXh
145Dh	LOANIO OLI 445 Ti Ci		XXh
145Eh	CAN0 Slot 15: Time Stamp		XXh
145Fh	LOANIO OLI LIMI I D. T.	000140	XXh
1460h	CAN0 Global Mask Register	COGMR	XXh
1461h	1		XXh
1462h	1		XXh
1463h			XXh
1464h			XXh
1465h	LOANOL IM LAB :	COLMAR	XXh
1466h	CAN0 Local Mask A Register	COLMAR	XXh
1467h	-		XXh
1468h	-		XXh
1469h	-		XXh
146Ah	-		XXh
146Bh	LOANOL IM I D.D	6011100	XXh
146Ch	CAN0 Local Mask B Register	COLMBR	XXh
146Dh	_		XXh
146Eh	_		XXh
146Fh			XXh
1470h			XXh
1471h			XXh
1472h			
1473h			
1474h			
1475h			
FFFFh	Option Function Select Register	OFS	(Note 2)

- The blank regions are reserved. Do not access locations in these regions.
 The OFS register cannot be changed by a program. Use a flash programmer to write to it.

Electrical Characteristics 5.

Table 5.1 **Absolute Maximum Ratings**

Symbol	Parameter	Condition	Rated value	Unit
Vcc/AVcc	Supply voltage		-0.3 to 6.5	V
Vı	Input voltage		-0.3 to Vcc+0.3	V
Vo	Output voltage		-0.3 to Vcc+0.3	V
Pd	Power dissipation	-40°C ≤ Topr ≤ 85°C	300	mW
		85°C < Topr ≤ 125°C	125	mW
Topr	Operating ambient temperature		-40 to 85 (D, J version) / -40 to 125 (K version)	°C
Tstg	Storage temperature		-65 to 150	°C

Table 5.2 **Recommended Operating Conditions**

0	Damanatan		0 100		Standard		Unit
Symbol	Parameter		Conditions	Min.	Тур.	Max.	Unit
Vcc/AVcc	Supply voltage			2.7	-	5.5	V
Vss/AVcc	Supply voltage			=	0	-	V
VIH	Input "H" voltage			0.8Vcc	=	Vcc	V
VIL	Input "L" voltage			0	_	0.2Vcc	V
IOH(sum)	Peak sum output "H" current	Sum of all Pins IOH (peak)		-	-	-60	mA
IOH(peak)	Peak output "H" current			-	_	-10	mA
IOH(avg)	Average output "H" current			=	=	-5	mA
IOL(sum)	Peak sum output "L" currents	Sum of all Pins IOL (peak)		_	-	60	mA
IOL(peak)	Peak output "L" currents			=	-	10	mA
IOL(avg)	Average output "L" current			=	-	5	mA
f(XIN)	XIN clock input oscillation from	equency	3.0 V ≤ Vcc ≤ 5.5 V -40°C ≤ Topr ≤ 85°C	0	-	20	MHz
			3.0 V ≤ Vcc ≤ 5.5 V -40°C ≤ Topr ≤ 125°C	0	-	16	MHz
			$2.7~\textrm{V} \leq \textrm{Vcc} < 3.0~\textrm{V}$	0	_	10	MHz
_	System clock	OCD2 = 0 When XIN	3.0 V ≤ Vcc ≤ 5.5 V -40°C ≤ Topr ≤ 85°C	0	-	20	MHz
		clock is selected.	3.0 V ≤ Vcc ≤ 5.5 V -40°C ≤ Topr ≤ 125°C	0	=	16	MHz
			2.7 V ≤ Vcc < 3.0 V	0	-	10	MHz
		OCD2 = 1 When on-chip oscillator clock is selected.	FRA01 = 0 When low-speed on- chip oscillator clock is selected.	-	125	_	kHz
			FRA01 = 1 When high-speed on- chip oscillator clock is selected. 3.0 V ≤ Vcc ≤ 5.5 V -40°C ≤ Topr ≤ 85°C	-	-	20	MHz
			FRA01 = 1 When high-speed on- chip oscillator clock is selected.	-	-	10	MHz

- 1. Vcc = 2.7 to 5.5 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.
- 2. The average output current indicates the average value of current measured during 100 ms.



Table 5.3 A/D Converter Characteristics

Cymphol		arameter	Conditions		Standard		Unit
Symbol		arameter	Conditions	Min.	Тур.	Max.	Onit
=	Resolution		Vref = AVCC	=	-	10	Bits
-	Absolute	10-bit mode	φAD = 10 MHz, Vref = AVcc = 5.0 V	=	-	±3	LSB
	Accuracy	8-bit mode	φAD = 10 MHz, Vref = AVcc = 5.0 V	=	-	±2	LSB
		10-bit mode	φAD = 10 MHz, Vref = AVcc = 3.3 V	=	-	±5	LSB
	8-bit mode	φAD = 10 MHz, Vref = AVcc = 3.3 V	=	-	±2	LSB	
Rladder	Resistor ladder		Vref = AVCC	10	-	40	kΩ
tconv	Conversion time	10-bit mode	φAD = 10 MHz, Vref = AVcc = 5.0 V	3.3	-	=	μS
		8-bit mode	φAD = 10 MHz, Vref = AVcc = 5.0 V	2.8	-	=	μS
Vref	Reference voltage	9		2.7	-	AVcc	V
VIA	Analog input voltage ⁽²⁾			0	_	AVcc	V
_	A/D operating	Without sample & hold		0.25	-	10	MHz
	clock frequency	With sample & hold		1	_	10	MHz

- Vcc = AVcc = 2.7 to 5.5 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.
 When analog input voltage exceeds reference voltage, A/D conversion result is 3FFh in 10-bit mode, FFh in 8-bit mode.

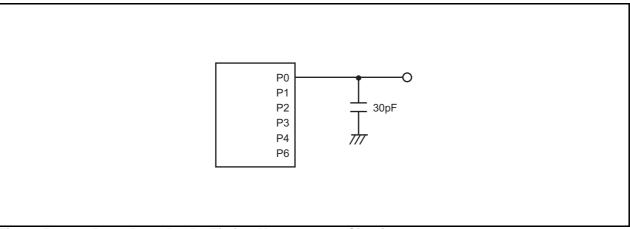


Figure 5.1 Ports P0 to P4, P6 Timing Measurement Circuit

Table 5.4 Flash Memory (Program ROM) Electrical Characteristics

Symbol	Parameter	Conditions		Unit		
Syllibol	Farameter	Conditions	Min.	Тур.	Max.	Offic
=	Program/erase endurance ⁽²⁾	R8C/22 Group	100(3)	=	=	times
		R8C/23 Group	1,000(3)	-	-	times
_	Byte program time		-	50	400	μS
-	Block erase time		=	0.4	9	S
td(SR-SUS)	Time delay from suspend request until erase suspend		_	_	97 + CPU clock × 6 cycle	μS
_	Interval from erase start/restart until following suspend request		650	-	_	μS
_	Interval from program start/restart until following suspend request		0	_	_	ns
_	Time from suspend until program/erase restart		-	-	3 + CPU clock × 4 cycle	μS
_	Program, erase voltage		2.7	-	5.5	V
_	Read voltage		2.7	-	5.5	V
_	Program, erase temperature		0	-	60	°C
_	Data hold time ⁽⁷⁾	Ambient temperature = 55°C	20	_	_	year

- 1. Vcc = 2.7 to 5.5 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.
- 2. Definition of programming/erasure endurance
 - The programming and erasure endurance is defined on a per-block basis.
 - If the programming and erasure endurance is n (n = 100 or 1,000), each block can be erased n times.
 - For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one. However, the same address must not be programmed more than once per erase operation (overwriting prohibited).
- 3. Endurance to guarantee all electrical characteristics after program and erase (1 to Min. value can be guaranteed).
- 4. In a system that executes multiple programming operations, the actual erasure endurance can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.
- 5. If error occurs during block erase, attempt to execute the clear status register command, then the block erase command at least three times until the erase error does not occur.
- 6. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
- 7. The data hold time includes time that the power supply is off or the clock is not supplied.

Table 5.5 Flash Memory (Data Flash Block A, Block B) Electrical Characteristics⁽⁴⁾

Cumbal	Parameter	Conditions		Unit		
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
_	Program/erase endurance ⁽²⁾		10,000(3)	-	_	times
=	Byte program time (Program/erase endurance ≤ 1,000 times)		=	50	400	μS
_	Byte program time (Program/erase endurance > 1,000 times)		_	65	_	μS
_	Block erase time (Program/erase endurance ≤ 1,000 times)		_	0.2	9	S
_	Block erase time (Program/erase endurance > 1,000 times)		_	0.3	_	S
td(SR-SUS)	Time delay from suspend request until erase suspend		_	-	97 + CPU clock × 6 cycle	μS
_	Interval from erase start/restart until following suspend request		650	-	_	μS
=	Interval from program start/restart until following suspend request		0	-	_	ns
_	Time from suspend until program/erase restart		_	-	3 + CPU clock × 4 cycle	μS
_	Program, erase voltage		2.7	_	5.5	V
_	Read voltage		2.7	_	5.5	V
_	Program, erase temperature		-40	-	85(8)	°C
_	Data hold time ⁽⁹⁾	Ambient temperature = 55°C	20	_	-	year

- 1. Vcc = 2.7 to 5.5 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.
- 2. Definition of programming/erasure endurance
 - The programming and erasure endurance is defined on a per-block basis.
 - If the programming and erasure endurance is n (n = 10,000), each block can be erased $n \times 10^{-1}$ times.
 - For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one. However, the same address must not be programmed more than once per erase operation (overwriting prohibited).
- 3. Minimum endurance to guarantee all electrical characteristics after program and erase (1 to Min. value can be guaranteed).
- 4. Standard of block A and block B when program and erase endurance exceeds 1,000 times. Byte program time to 1,000 times are the same as that in program ROM.
- 5. In a system that executes multiple programming operations, the actual erasure endurance can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. In addition, averaging the erasure endurance between blocks A and B can further reduce the actual erasure endurance. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.
- 6. If error occurs during block erase, attempt to execute the clear status register command, then the block erase command at least three times until the erase error does not occur.
- 7. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
- 8. 125°C for K version.
- 9. The data hold time includes time that the power supply is off or the clock is not supplied.

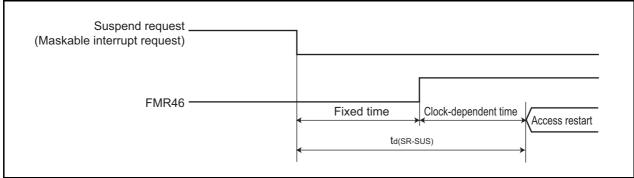


Figure 5.2 Time delay until Suspend

Table 5.6 Voltage Detection 1 Circuit Electrical Characteristics

Symbol	Parameter	Condition -	Standard			Unit
	Farameter		Min.	Тур.	Max.	Offic
Vdet1	Voltage detection level ^(3, 4)		2.70	2.85	3.00	V
td(Vdet1-A)	Voltage monitor 1 reset generation time ⁽⁵⁾		-	40	200	μS
=	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	=	0.6	=	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽²⁾		-	=	100	μS
Vccmin	MCU operating voltage minimum value		2.70	-	-	V

- 1. The measurement condition is Vcc = 2.7 V to 5.5 V and Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version).
- 2. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.
- 3. Hold Vdet2 > Vdet1.
- 4. This parameter shows the voltage detection level when the power supply drops. The voltage detection level when the power supply rises is higher than the voltage detection level when the power supply drops by approximately 0.1 V.
- 5. Time until the voltage monitor 1 reset is generated after the voltage passes V_{det1} when V_{CC} falls. When using the digital filter, its sampling time is added to td(V_{det1-A}). When using the voltage monitor 1 reset, maintain this time until V_{CC} = 2.0 V after the voltage passes V_{det1} when the power supply falls.

Table 5.7 Voltage Detection 2 Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
	Faranielei		Min.	Тур.	Max.	Offic
Vdet2	Voltage detection level ⁽⁴⁾		3.3	3.6	3.9	V
td(Vdet2-A)	Voltage monitor 2 reset/interrupt request generation time ^(2, 5)		=	40	200	μS
=	Voltage detection circuit self power consumption	VCA27 = 1, Vcc = 5.0V	-	0.6	_	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		=	=	100	μS

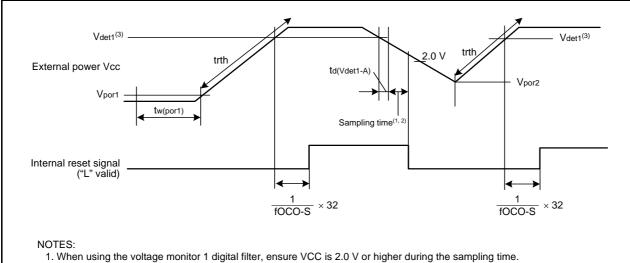
- 1. The measurement condition is Vcc = 2.7 V to 5.5 V and Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version).
- 2. Time until the voltage monitor 2 reset/interrupt request is generated since the voltage passes Vdet2.
- 3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.
- 4. Hold Vdet2 > Vdet1.
- 5. When using the digital filter, its sampling time is added to td(Vdet2-A). When using the voltage monitor 2 reset, maintain this time until Vcc = 2.0 V after the voltage passes Vdet2 when the power supply falls.



Table 5.8 Power-on Reset Circuit, Voltage Monitor 1 Reset Circuit Electrical Characteristics(3)

Symbol	Parameter	Condition	Standard			Unit
			Min.	Тур.	Max.	
Vpor1	Power-on reset valid voltage ⁽⁴⁾		-	-	0.1	V
Vpor2	Power-on reset or voltage monitor 1 valid voltage		0	_	Vdet1	V
trth	External power Vcc rise gradient	Vcc ≤ 3.6 V	20(2)	-	_	mV/msec
		Vcc > 3.6 V	20(2)	-	2,000	mV/msec

- 1. Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version), unless otherwise specified.
- 2. This condition (the minimum value of external power Vcc rise gradient) does not apply if V_{por2} ≥ 1.0 V.
- 3. To use the power-on reset function, enable voltage monitor 1 reset by setting the LVD10N bit in the OFS register to 0, the VW1C0 and VW1C6 bits in the VW1C register to 1 respectively, and the VCA26 bit in the VCA2 register to 1.
- 4. tw(por1) indicates the duration the external power Vcc must be held below the effective voltage (Vpor1) to enable a power on reset. When turning on the power for the first time, maintain tw(por1) for 30s or more if $-20^{\circ}C \le Topr \le 125^{\circ}C$, maintain tw(por1) for 30s or more if $-20^{\circ}C \le Topr \le 125^{\circ}C$, maintain tw(por1) for 3,000s or more if -40° C \leq Topr $< -20^{\circ}$ C.



- 2. The sampling clock can be selected. Refer to 6. Voltage Detection Circuit of Hardware Manual for details.
- 3. Vdet1 indicates the voltage detection level of the voltage detection 1 circuit. Refer to 6. Voltage Detection Circuit of Hardware Manual for details.

Figure 5.3 **Power-on Reset Circuit Electrical Characteristics**

Table 5.9 High-Speed On-Chip Oscillator Circuit Electrical Characteristics

Cymphal	Parameter	Condition	,	Standard	d	Unit
Symbol	Farameter	Condition	Min.	Тур.	Max.	
fOCO40M	High-speed on-chip oscillator frequency temperature	Vcc = 4.75 V to 5.25 V,	39.2	40	40.8	MHz
	supply voltage dependence	$0^{\circ}C \leq Topr \leq 60^{\circ}C^{(2)}$				
		Vcc = 3.0 V to 5.25 V,	38.8	40	41.2	MHz
		-20 °C \leq Topr \leq 85°C(2)				
		Vcc = 3.0 V to 5.5 V,	38.4	40	41.6	MHz
		-40 °C \leq Topr \leq 85°C(2)				
		Vcc = 3.0 V to 5.5 V,	38.0	40	42.0	MHz
		-40 °C \leq Topr \leq 125°C(2)				
		Vcc = 2.7 V to 5.5 V,	37.6	40	42.4	MHz
		-40 °C \leq Topr \leq 125°C ⁽²⁾				
_	The value of the FRA1 register when the reset is		08h	40	F7h	_
	deasserted					
_	High-speed on-chip oscillator adjustment range	Adjust the FRA1 register to	-	+ 0.3	-	MHz
		-1 bit (the value when the				
		reset is deasserted)				
=	Oscillation stability time		_	10	100	μS
_	Self power consumption when high-speed on-chip oscillator oscillating	Vcc = 5.0 V, Topr = 25°C	=	600	=	μА

- 1. Vcc = 2.7 V to 5.5 V, $Topr = -40^{\circ}\text{C}$ to 85°C (D, J version) / -40°C to 125°C (K version), unless otherwise specified.
- 2. The standard value shows when the reset is deasserted for the FRA1 register.

Table 5.10 Low-Speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
Symbol	Falantete	Parameter Condition		Тур.	Max.	Offic
fOCO-S	Low-speed on-chip oscillator frequency		40	125	250	kHz
_	Oscillation stability time		-	10	100	μS
_	Self power consumption when low-speed on-chip oscillator oscillating	Vcc = 5.0 V, Topr = 25°C	II	15		μА

NOTE:

1. Vcc = 2.7 V to 5.5 V, Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version), unless otherwise specified.

Table 5.11 Power Supply Circuit Timing Characteristics

Symbol Parameter	Parameter	Condition	°,	Unit		
	Condition	Min.	Тур.	Max.	Offic	
td(P-R)	Time for internal power supply stabilization during power-on ⁽²⁾		1	=	2000	μS
td(R-S)	STOP exit time ⁽³⁾		-	-	150	μS

- 1. The measurement condition is Vcc = 2.7 to 5.5 V and Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.
- 2. Waiting time until the internal power supply generation circuit stabilizes during power-on.
- 3. Time until CPU clock supply starts since the interrupt is acknowledged to exit stop mode.



Table 5.12 Timing Requirements of Clock Synchronous Serial I/O with Chip Select(1)

Cumbal	Parameter		Conditions		Standard			
Symbol	Parameter		Conditions	Min.	Тур.	Max.	Unit	
tsucyc	SSCK clock cycle time			4	=	=	tcyc(2)	
tHI	SSCK clock "H" width			0.4	-	0.6	tsucyc	
tLO	SSCK clock "L" width			0.4	-	0.6	tsucyc	
trise	SSCK clock rising time	Master		=	-	1	tcyc(2)	
		Slave		-	-	1	μS	
tfall	SSCK clock falling time	Master		=	=	1	tcyc(2)	
		Slave		-	-	1	μS	
tsu	SSO, SSI data input setup time			100	=	-	ns	
tH	SSO, SSI data input hold time			1	=	=	tcyc(2)	
tLEAD	SCS setup time	Slave		1tcyc + 50	_	_	ns	
tLAG	SCS hold time	Slave		1tcyc + 50	-	=	ns	
top	SSO, SSI data output delay time	9		-	-	1	tcyc ⁽²⁾	
tsa	SSI slave access time			-	-	1tcyc + 100	ns	
tor	SSI slave out open time			-	-	1tcyc + 100	ns	

- Vcc = 2.7 to 5.5 V, Vss = 0 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.
 1. Vcc = 2.7 to 5.5 V, Vss = 0 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.
 2. 1tcyc = 1/f1(s)

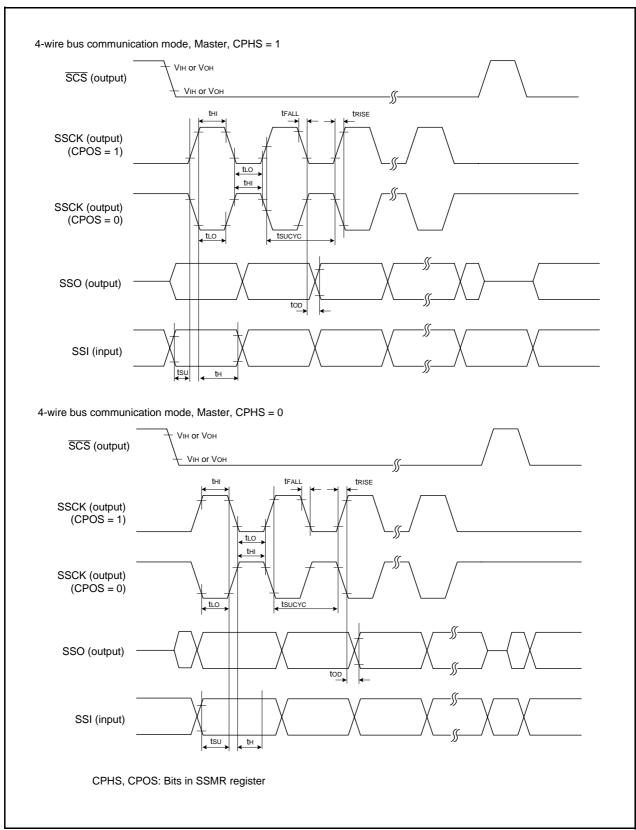


Figure 5.4 I/O Timing of Clock Synchronous Serial I/O with Chip Select (Master)

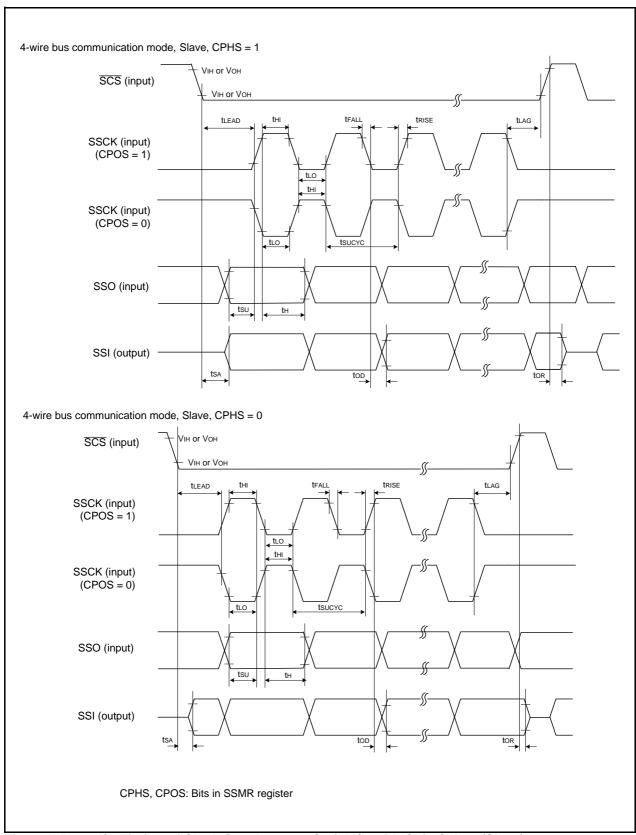
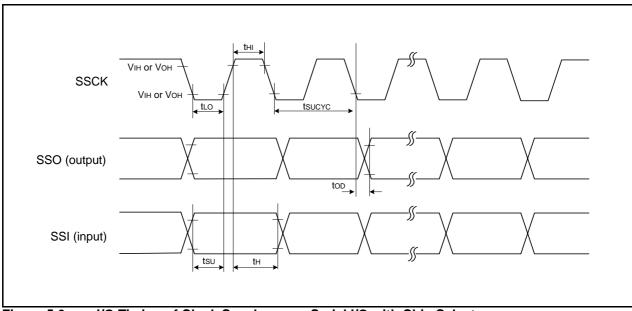


Figure 5.5 I/O Timing of Clock Synchronous Serial I/O with Chip Select (Slave)



I/O Timing of Clock Synchronous Serial I/O with Chip Select (Clock Synchronous Communication Mode) Figure 5.6

Table 5.13 Timing Requirements of I²C Bus Interface⁽¹⁾

Cumbal	Parameter	Conditions		Standard			
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
tscl	SCL input cycle time		12tcyc + 600 ⁽²⁾	-	-	ns	
tsclh	SCL input "H" width		3tcyc + 300 ⁽²⁾	_	-	ns	
tscll	SCL input "L" width		5tcyc + 500 ⁽²⁾	_	-	ns	
tsf	SCL, SDA input falling time		-	-	300	ns	
tsp	SCL, SDA input spike pulse rejection time		=	-	1tcyc(2)	ns	
tBUF	SDA input bus-free time		5tcyc(2)	-	=	ns	
tstah	Start condition input hole time		3tcyc(2)	-	-	ns	
tstas	Retransmit start condition input setup time		3tcyc(2)	_	=	ns	
tstop	Stop condition input setup time		3tcyc(2)	-	-	ns	
tsoas	Data input setup time		1tcyc + 20 ⁽²⁾	_	=	ns	
tsdah	Data input hold time		0	-	-	ns	

- 1. Vcc = 2.7 to 5.5 V, Vss = 0V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.
 2. 1tcyc = 1/f1(s)

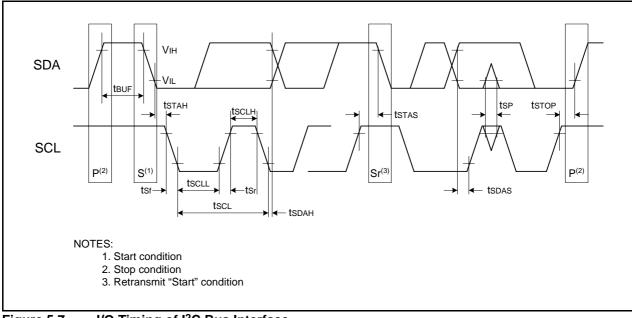


Figure 5.7 I/O Timing of I²C Bus Interface

Electrical Characteristics (1) [Vcc = 5 V] **Table 5.14**

Cumbal	Doro	meter	Condit	ion	St	andard		Unit
Symbol	Pala	meter	Condit	ion	Min.	Тур.	Max.	Unit
Vон	Output "H" Voltage	Except XOUT	Iон = -5 mA		Vcc - 2.0	_	Vcc	V
			Іон = -200 μА		Vcc - 0.3	_	Vcc	V
		XOUT	Drive capacity HIGH	Iон = -1 mA	Vcc - 2.0	=	Vcc	V
			Drive capacity LOW	ΙΟΗ = -500 μΑ	Vcc - 2.0	-	Vcc	V
Vol	Output "L" Voltage	Except XOUT	IoL = 5 mA		-	-	2.0	V
			IoL = 200 μA		-	-	0.45	V
		XOUT	Drive capacity HIGH	IOL = 1 mA	=	=	2.0	V
			Drive capacity LOW	IOL = 500 μA	=	-	2.0	V
VT+-VT-	Hysteresis	INTO, INT1, INT2, INT3, KIO, KI1, KI2, KI3, TRAIO, RXDO, RXD1, CLKO, SSI, SCL, SDA, SSO			0.1	0.5	=	V
		RESET			0.1	1.0	-	V
lін	Input "H" current	-	VI = 5 V, Vcc = 5 V		-	_	5.0	μΑ
lıL	Input "L" current		VI = 0 V, Vcc = 5 V		-	-	-5.0	μΑ
RPULLUP	Pull-Up Resistance		VI = 0 V, Vcc = 5 V		30	50	167	kΩ
RfXIN	Feedback Resistance	XIN			-	1.0	-	ΜΩ
VRAM	RAM Hold Voltage	•	During stop mode		2.0	_	-	V

^{1.} Vcc = 4.2 to 5.5 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), f(XIN) = 20 MHz, unless otherwise specified.

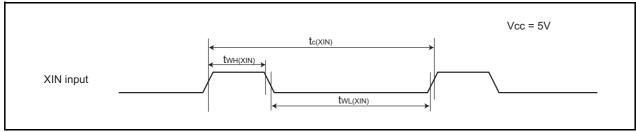
Electrical Characteristics (2) [Vcc = 5 V] **Table 5.15** (Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), Unless Otherwise Specified.)

Symbol	Parameter		Condition	Standard			Unit
	i didiliolei			Min.	Тур.	Max.	Jill
Icc	Power supply current (Vcc = 3.3 to 5.5 V) In single-chip mode, the output pins are	High-clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	12.5	25.0	mA
	open and other pins are Vss		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	10.0	20.0	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	I	6.5	Ī	mA
		XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	1	6.5	1	mA	
			XIN = 16MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	5.0	_	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	3.5	_	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division	I	6.5	13.0	mA
			XIN clock off High-speed on-chip oscillator on fOCO= 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	3.2	ı	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 FMR47 = 1	-	150	300	μА
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA20 = 0 VCA26 = VCA27 = 0	-	60	120	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA20 = 0 VCA26 = VCA27 = 0		38	76	μА
		Stop mode Topr = 25°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	=	0.8	3.0	μА
		Stop mode Topr = 85°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	=	1.2	=	μА
		Stop mode Topr = 125°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	-	4.0	=	μА

Timing Requirements (Unless Otherwise Specified: Vcc = 5 V, Vss = 0 V at Topr = 25°C) [Vcc = 5 V]

Table 5.16 XIN Input

Symbol	Parameter		Standard		
			Max.	Unit	
tc(XIN)	XIN input cycle time	50	=	ns	
twh(xin)	XIN input "H" width	25	=	ns	
twl(xin)	XIN input "L" width	25	-	ns	



XIN Input Timing Diagram when Vcc = 5 V Figure 5.8

Table 5.17 TRAIO Input

Symbol	Parameter		Standard		
	Falanielei	Min.	Max.	Unit	
tc(TRAIO)	TRAIO input cycle time	100	-	ns	
tWH(TRAIO)	TRAIO input "H" width	40	-	ns	
twl(traio)	TRAIO input "L" width	40	=	ns	

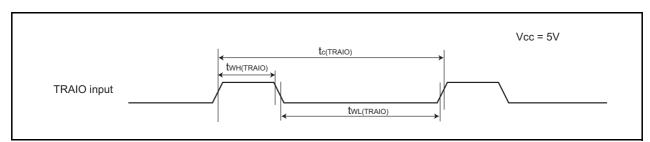
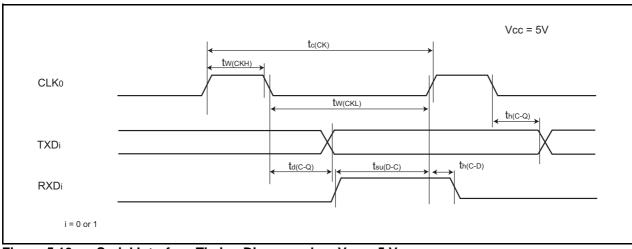


Figure 5.9 TRAIO Input Timing Diagram when Vcc = 5 V

Table 5.18 Serial Interface

Symbol	Parameter	Stan	Unit	
Symbol	i didiffetet			Max.
tc(CK)	CLK0 input cycle time	200	=	ns
tW(CKH)	CLK0 input "H" width	100	-	ns
tW(CKL)	CLK0 input "L" width	100	-	ns
td(C-Q)	TXDi output delay time	-	50	ns
th(C-Q)	TXDi hold time	0	-	ns
tsu(D-C)	RXDi input setup time	50	=	ns
th(C-D)	RXDi input hold time	90	-	ns

i = 0 or 1

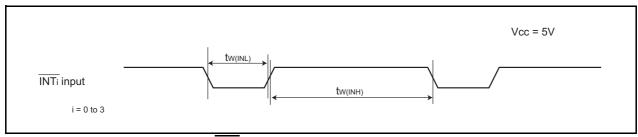


Serial Interface Timing Diagram when Vcc = 5 V Figure 5.10

External Interrupt INTi (i = 0 to 3) Input **Table 5.19**

Symbol	Parameter		Standard		
			Max.	Unit	
tW(INH)	ĪNTi input "H" width	250 ⁽¹⁾	-	ns	
tW(INL)	INTi input "L" width	250 ⁽²⁾	1	ns	

- 1. When selecting the digital filter by the $\overline{\text{INTi}}$ input filter select bit, use the $\overline{\text{INTi}}$ input HIGH width to the greater value, either (1/digital filter clock frequency x 3) or the minimum value of standard.
- 2. When selecting the digital filter by the INTi input filter select bit, use the INTi input LOW width to the greater value, either (1/digital filter clock frequency x 3) or the minimum value of standard.



External Interrupt INTi Input Timing Diagram when Vcc = 5 V (i = 0 to 3) Figure 5.11

Electrical Characteristics (3) [Vcc = 3 V] **Table 5.20**

Symbol	Paran	notor	Condit	tion	Standard			Unit
Symbol	Paran	neter	Condi	lion	Min.	Тур.	Max.	Unit
Vон	Output "H" voltage	Except XOUT	Iон = -1 mA		Vcc - 0.5	-	Vcc	V
		XOUT	Drive capacity HIGH	Iон = -0.1 mA	Vcc - 0.5	_	Vcc	V
			Drive capacity LOW	IOH = -50 μA	Vcc - 0.5	=	Vcc	V
Vol	Output "L" voltage	Except XOUT	IoL = 1 mA		-	-	0.5	V
		XOUT	Drive capacity HIGH	IoL = 0.1 mA	=	=	0.5	V
			Drive capacity LOW	IOL = 50 μA	=	_	0.5	V
VT+-VT-	Hysteresis	NT0, NT1, NT2, NT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, RXD1, CLK0, SSI, SCL, SDA, SSO			0.1	0.3	-	V
		RESET			0.1	0.4	-	V
lін	Input "H" current	•	VI = 3 V, Vcc = 3 V		_	_	4.0	μΑ
lıL	Input "L" current		VI = 0 V, Vcc = 3 V		_	_	-4.0	μΑ
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 3 V		66	160	500	kΩ
RfXIN	Feedback resistance	XIN			-	3.0	_	МΩ
VRAM	RAM hold voltage	•	During stop mode		2.0	1	_	V

^{1.} Vcc = 2.7 to 3.3 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), f(XIN) = 10 MHz, unless otherwise specified.

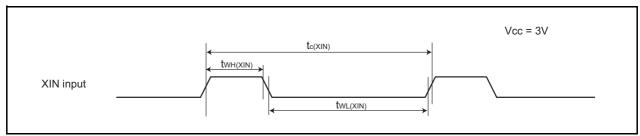
Electrical Characteristics (4) [Vcc = 3 V] **Table 5.21** (Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), Unless Otherwise Specified.)

Symbol	Parameter	Parameter Condition			Standard Max		
-,				Min.	Тур.	Max.	Unit
Icc	Power supply current (Vcc = 2.7 to 3.3 V) In single-chip mode, the output pins are	High-clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	=	11.5	23.0	mA
	open and other pins are Vss		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	=	9.5	19.0	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	6.0	12.0	mA
		XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	5.5	-	mA	
		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_,	4.5	=	mA	
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	3.0	_	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division	_	6.3	12.6	mA
			XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	3.1	-	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 FMR47 = 1	_	145	290	μА
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA20 = 0 VCA26 = VCA27 = 0	-	56	112	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA20 = 0 VCA26 = VCA27 = 0	_	35	70	μА
		Stop mode Topr = 25°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	-	0.7	3.0	μА
		Stop mode Topr = 85°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	_	1.1	_	μА
		Stop mode Topr = 125°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	=	3.8	_	μА

Timing Requirements (Unless Otherwise Specified: Vcc = 3 V, Vss = 0V at Topr = 25°C) [Vcc = 3 V]

Table 5.22 XIN Input

Symbol	Parameter		Standard		
			Max.	Unit	
tc(XIN)	XIN input cycle time	100	=	ns	
twh(xin)	XIN input "H" width	40	=	ns	
twl(xin)	XIN input "L" width	40	_	ns	



XIN Input Timing Diagram when Vcc = 3 V Figure 5.12

Table 5.23 TRAIO Input

Symbol	Parameter		Standard		
Symbol	,	Min.	Max.	Unit	
tc(TRAIO)	TRAIO input Cycle time	300	-	ns	
twh(traio)	TRAIO input "H" width	120	-	ns	
twl(traio)	TRAIO input "L" width	120	_	ns	

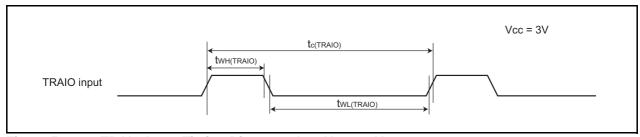


Figure 5.13 TRAIO Input Timing Diagram when Vcc = 3 V

Table 5.24 Serial Interface

Symbol	Parameter	Stan	Unit	
	Falanetei	Min.	Max.	Offic
tc(CK)	CLK0 input cycle time	300	=	ns
tW(CKH)	CLK0 input "H" width	150	-	ns
tW(CKL)	CLK0 input "L" width	150	-	ns
td(C-Q)	TXDi output delay time	-	80	ns
th(C-Q)	TXDi hold time	0	-	ns
tsu(D-C)	RXDi input setup time	70	=	ns
th(C-D)	RXDi input hold time	90	-	ns

i = 0 or 1

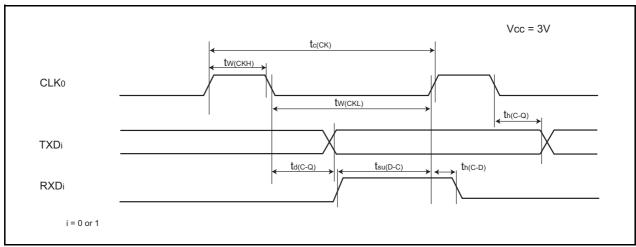
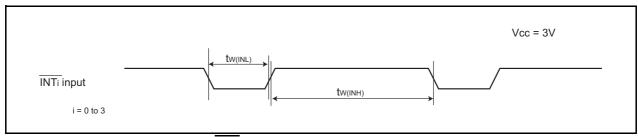


Figure 5.14 Serial Interface Timing Diagram when Vcc = 3 V

External Interrupt INTi (i = 0 to 3) Input **Table 5.25**

Symbol	Parameter	Standard		Unit
	Falanielei		Max.	
tw(INH)	ĪNTi input "H" width	380(1)	-	ns
tw(INL)	INTi input "L" width	380(2)	1	ns

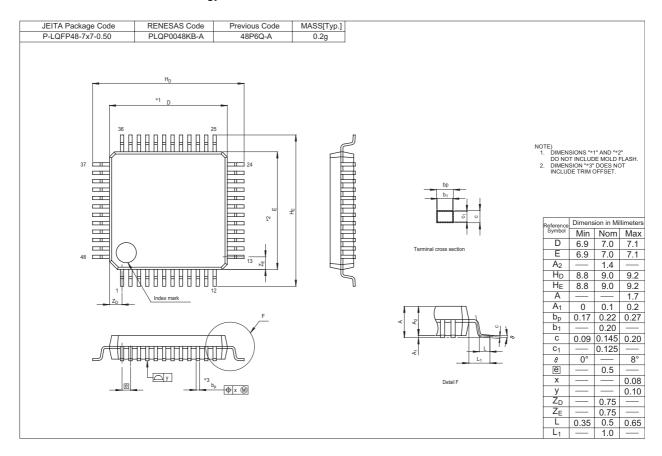
- 1. When selecting the digital filter by the $\overline{\text{INTi}}$ input filter select bit, use the $\overline{\text{INTi}}$ input HIGH width to the greater value, either (1/digital filter clock frequency x 3) or the minimum value of standard.
- 2. When selecting the digital filter by the INTi input filter select bit, use the INTi input LOW width to the greater value, either (1/digital filter clock frequency x 3) or the minimum value of standard.



External Interrupt INTi Input Timing Diagram when Vcc = 3 V (i = 0 to 3) Figure 5.15

Package Dimensions

Diagrams showing the latest package dimensions and mounting information are available in the "Packages" section of the Renesas Technology website.



REVISION HISTORY

R8C/22 Group, R8C/23 Group Datasheet

	Data	Description	
Rev.	Date	Page	Summary
0.10	Mar 08, 2005	-	First Edition issued
0.20	Sep 29, 2005	_	Words standardized - Clock synchronous serial interface → Clock synchronous serial I/O - Chip-select clock synchronous interface(SSU) → Clock synchronous serial I/O with chip select - I ² C bus interface(IIC) → I ² C bus interface
		2, 3	Table1.1 R8C/22 Group Performance, Table1.2 R8C/23 Group Performance Serial Interface revised: - Clock Synchronous Serial Interface: 1 channel I2C bus Interface (3), Clock synchronous serial I/O with chip select - Power-On Reset Circuit added - Power Consumption value determined
		5, 6	Table 1.3 Product Information of R8C/22 Group, Table 1.4 Product Information of R8C/23 Group Date revised.
		7	Figure 1.4 Pin Assignment Pin name revised: $ - P3_5/SSCK(/SCL) \rightarrow P3_5/SCL/SSCK \\ - P3_4/SCS(/SDA) \rightarrow P3_4/SDA/SCS \\ - VSS \rightarrow VSS/AVSS \\ - VCC \rightarrow VCC/AVCC \\ - P1_5/RXD0/(TRAIO/INT1) \rightarrow P1_5/RXD0/(TRAIO)/(INT1) \\ - P6_6/INT2/(TXD1) \rightarrow P6_6/INT2/TXD1 \\ - P6_7/INT3/(RXD1) \rightarrow P6_7/INT3/RXD1 \\ - NOTE2 added $
		8	Table 1.5 Pin Description - Analog Power Supply Input: line added - I ² C Bus Interface (IIC) → I ² C Bus Interface - SSU → Clock Synchronous Serial I/O with Chip Select
		9	Table 1.6 Pin Name Information by Pin Number revised - Pin Number 1: (SCL) → SCL - Pin Number 2: (SDA) → SDA - Pin Number 9: VSS → VSS/AVSS - Pin Number 11: VCC → VCC/AVCC - Pin Number 26: (TXD1) → TXD1 - Pin Number 27: (RXD1) → RXD1
		15	Table 4.1 SFR Information (1) revised - 0013h: XXXXXX00b → 00h
		17	Table 4.3 SFR Information (3) revised - 00BCh: 0000X000b → 00h/0000X000b
		18	Table 4.4 SFR Information (4) revised - 00D6h: 00000XXXb → 00h - 00F5h: UART1 Function Select Register added
		19	Table 4.5 SFR Information (5) revised - 0104h: TRATR → TRA

R8C/22 Group, R8C/23 Group Datasheet

Pov	Data	Description	
Rev.	Date	Page	Summary
0.20	Sep 29, 2005	20	Table 4.6 SFR Information (6) revised - 0145h: POCR0 → TRDPOCR0 - 0146h, 0147h: TRDCNT0 → TRD0 - 0148h, 0149h: GRA0 → TRDGRA0 - 014Ah, 014Bh: GRB0 → TRDGRB0 - 014Ch, 014Dh: GRC0 → TRDGRC0 - 014Eh, 014Fh: GRD0 → TRDGRD0 - 0155h: POCR1 -> TRDPOCR1 - 0156h, 0157h: TRDCNT1 → TRD1 - 0158h, 0159h: GRA1 → TRDGRA1 - 015Ch, 015Dh: GRC1 → TRDGRC1 - 015Eh, 015Fh: GRD1 → TRDGRD1
		28	5. Electrical Characteristics added
1.00	Oct 27, 2006	All pages	"Preliminary" and "Under development" deleted
		2	Table 1.1 Functions and Specifications for R8C/22 Group revised. NOTE1 deleted.
		3	Table 1.2 Functions and Specifications for R8C/23 Group revised. NOTE1 deleted.
		5	Table 1.3 Product Information for R8C/22 Group; "R5F2122AJFP (D)", "R5F2122CJFP (D)", "R5F2122AKFP (D)", "R5F2122CKFP (D)", and NOTE added. Figure 1.2 Type Number, Memory Size, and Package of R8C/22 Group; "A: 96 KB" and "C: 128 KB" added.
		6	Table 1.4 Product Information for R8C/23 Group; "R5F2123AJFP (D)", "R5F2123CJFP (D)", "R5F2123AKFP (D)", "R5F2123CKFP (D)", and NOTE added. Figure 1.3 Type Number, Memory Size, and Package of R8C/23 Group; "A: 96 KB" and "C: 128 KB" added.
		13	Figure 3.1 Memory Map of R8C/22 Group revised.
		14	Figure 3.2 Memory Map of R8C/23 Group revised.
		15	Table 4.1 SFR Information (1) ⁽¹⁾ ; NOTE8; "The CSPROINI bit in the OFS register is set to 0." \rightarrow "The CSPROINI bit in the OFS register is 0." revised.
		28	Table 5.1 Absolute Maximum Ratings; Power dissipation revised. Table 5.2 Recommended Operating Conditions; System clock revised.
		33	Table 5.8 Voltage Monitor 1 Reset Circuit Electrical Characteristics → Table 5.8 Power-on Reset Circuit, Voltage Monitor 1 Reset Circuit Electrical Characteristics ⁽¹⁾ replaced. Table 5.8 revised. NOTE3 added. Table 5.9 Power-on Reset Circuit Electrical Characteristics deleted. Figure 5.3 Power-on Reset Circuit Electrical Characteristics revised.
		34	Table 5.10 High-Speed On-Chip Oscillator Circuit Electrical Characteristics → Table 5.9 High-Speed On-Chip Oscillator Circuit Electrical Characteristics revised.

REVISION HISTORY

R8C/22 Group, R8C/23 Group Datasheet

Day	Dete	Description	
Rev.	Date	Page	Summary
1.00	Oct 27, 2006	40	Table 5.15 Electrical Characteristics (1) [VCC = 5 V] → Table 5.14 Electrical Characteristics (1) [VCC = 5 V] revised. RAM Hold Voltage, Min.; "1.8" → "2.0" corrected.
		41	Table 5.16 Electrical Characteristics (2) [Vcc = 5 V] → Table 5.15 Electrical Characteristics (2) [Vcc = 5 V] revised. Wait mode revised.
		44	Table 5.21 Electrical Characteristics (3) [VCC = 3 V → Table 5.20 Electrical Characteristics (3) [VCC = 3 V] revised. RAM hold voltage, Min.; "1.8" → "2.0" corrected.
		45	Table 5.22 Electrical Characteristics (4) [Vcc = 3 V] → Table 5.21 Electrical Characteristics (4) [Vcc = 3 V] revised. Wait mode revised.
1.10	Mar 16, 2007	-	D version products added. Relevant descriptions revised because of expanding products - Table 1.1 to 1.4 revised Figure 1.2 and 1.3 revised Figure 3.1 and 3.2 revised Table 5.1 to 5.15 revised Table 5.20 and 5.21 revised.
		15	Table 4.1 revised; 000Ah: "00XXX000b" → "00h", 000Fh: "00011111b" → "00X11111b"
		42	Table 5.17 and Figure 5.9 revised; "INT1 input" deleted
		43	Table 5.19 and Figure 5.11 revised; " $i = 0, 2, 3$ " \rightarrow " $i = 0$ to 3"
		46	Table 5.23 and Figure 5.13 revised; "INT1 input" deleted
		47	Table 5.25 and Figure 5.15 revised; "i = 0, 2, 3" \rightarrow "i = 0 to 3"
2.00	Aug 20, 2008	-	"RENESAS TECHNICAL UPDATE" reflected: TN-16C-A172A/E
		5, 6	Table 1.3, Table 1.4 revised Figure 1.2, Figure 1.3; ROM number "XXX" added
		13, 14	Figure 3.1, Figure 3.2; "Expanding area" deleted
		23	Table 4.9 135Fh Address "XXXX0000b" → "00h"
		28	Table 5.2; NOTE2 revised
		30	Table 5.4; NOTE2 and NOTE4 revised
		31	Table 5.5; NOTE2 and NOTE5 revised
		32	Table 5.6; "td(Vdet1-A)" added, NOTE5 added Table 5.7; "td(Vdet2-A)" and NOTE2 revised, NOTE5 added
		33	Table 5.8; "trth" and NOTE2 revised, Figure 5.3 revised

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